Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note: Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp. Customer Support Dept. April 1, 2003



MITSUBISHI MICROCOMPUTERS 7480/7481 GROUP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

DESCRIPTION

The 7480/7481 group is the single-chip microcomputer adopting the silicon gate CMOS process. In addition to its simple instruction set, the ROM, RAM, and I/O addresses are placed in the same memory space.

Having built-in serial I/O, A-D converter, and watchdog timer, this single-chip microcomputer is useful for control of automobiles, office automation equipment and home electric appliances.

The 7480/7481 group includes multiple types which differ in the memory type, size, and package.

FFATURES

realure5
●Number of basic machine language instructions71
ullet Minimum instruction execution time
(at 8 MHz clock input oscillation frequency)
●Memory size ROM 4 K to 16 K bytes
RAM 128 to 448 bytes
● Programmable I/O ports
(P0, P1, P4, P5) 24 (7481 group)
● Input ports
(P2, P3) 12 (7481 group)
●Built-in programmable pull-up transistors (P0, P1)
●Built-in clamp diodes
(P4, P5) 8 (7481 group)
●Interrupt
●Timer X, Y
●Timer 1, 2
● Serial I/O 8-bit x 1 (UART or clock-synchronized)
● A-D converter 8-bit x 4 channels (7480 group)
8-bit x 8 channels (7481 group)
■ Built-in watchdog timer
● Power source voltage2.7 to 4.5 V
(at [2.2 Vcc-2] MHz clock input oscillation frequency)
4.5 to 5.5 V
(at 8 MHz clock input oscillation frequency)
● Power dissipation
(at 8 MHz clock input oscillation frequency and 5 V power
source voltage)

APPLICATIONS

Automobiles, office automation equipment, home electric appliances, etc.

PIN CONFIGURATION

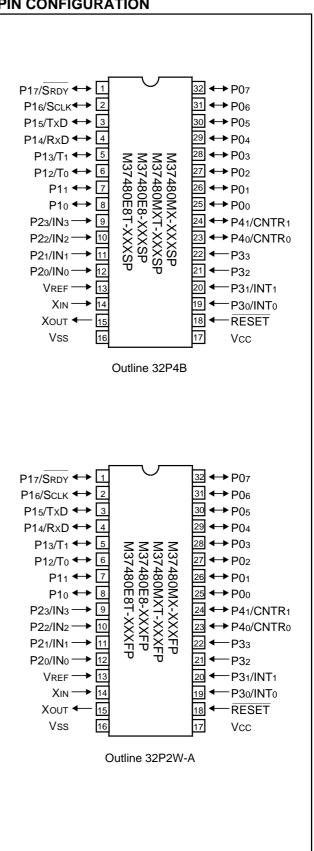


Fig. 1 Pin configuration (top view)





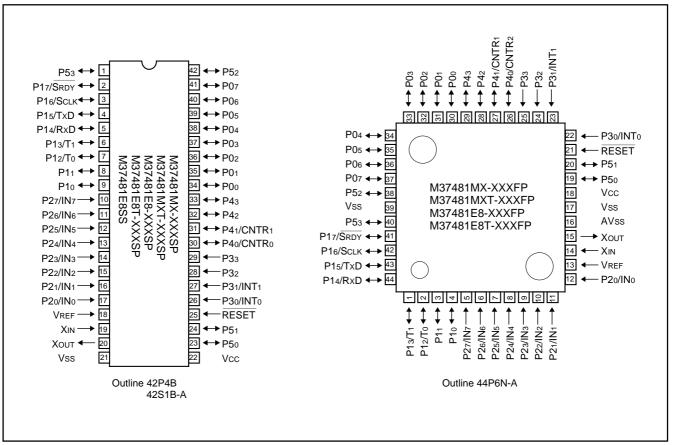


Fig. 2 Pin configuration (top view)



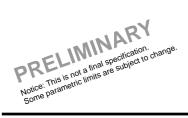
SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

7480/7481 GROUP PRODUCT LIST

Table 1.7480/7481 group product list

Product model name	ROM (bytes)	RAM (bytes)	I/O port	Package	Remarks
M37480M2T-XXXSP	4096	128	18 I/O ports	32P4B	- Mask ROM version*
M37480M2T-XXXFP	4096			32P2W-A	
M37480M4-XXXSP		256		32P4B	Mask ROM version
M37480M4-XXXFP	8192			32P2W-A	
M37480M4T-XXXSP	0192			32P4B	Mask ROM version*
M37480M4T-XXXFP				32P2W-A	
M37480M8-XXXSP		440		32P4B	Mask ROM version
M37480M8-XXXFP			,	32P2W-A	Widsk KOW Version
M37480M8T-XXXSP			8 input ports (including 4 analog	32P4B	Mask ROM version*
M37480M8T-XXXFP			input ports)	32P2W-A	Widsk ROW Version
M37480E8SP	16384			32P4B	One time PROM version
M37480E8FP	10364	448		32P2W-A	(shipped in blank)
M37480E8-XXXSP				32P4B	0 11 55011
M37480E8-XXXFP				32P2W-A	One time PROM version
M37480E8T-XXXSP				32P4B	One time PROM version
M37480E8T-XXXFP				32P2W-A	
M37481M2T-XXXSP	4096	128	24 I/O ports 12 input ports (including 8 analog input ports)	42P4B	Mask ROM version*
M37481M2T-XXXFP	4096			44P6N-A	
M37481M4-XXXSP		256		42P4B	Mask ROM version
M37481M4-XXXFP	8192			44P6N-A	
M37481M4T-XXXSP	6192			42P4B	Mask ROM version*
M37481M4T-XXXFP				44P6N-A	
M37481M8-XXXSP		448		42P4B	Mask ROM version
M37481M8-XXXFP				44P6N-A	
M37481M8T-XXXSP				42P4B	Mask ROM version*
M37481M8T-XXXFP				44P6N-A	
M37481E8SP	16394			42P4B	One time PROM version (shipped in blank)
M37481E8FP	- 16384 - -			44P6N-A	
M37481E8-XXXSP				42P4B	One time PROM version
M37481E8-XXXFP				44P6N-A	
M37481E8T-XXXSP				42P4B	One time PROM version*
M37481E8T-XXXFP				44P6N-A	
M37481E8SS				42S1B-A	Built-in EPROM version

^{*:} Extended operating temperature range version



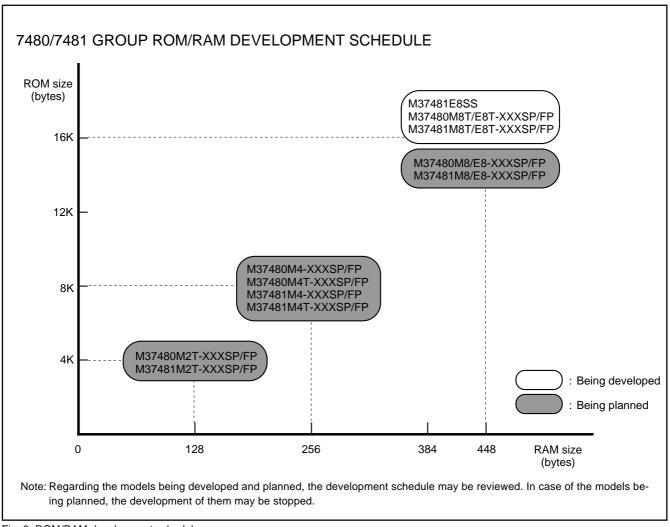


Fig. 3 ROM/RAM development schedule



FUNCTIONAL BLOCK DIAGRAM

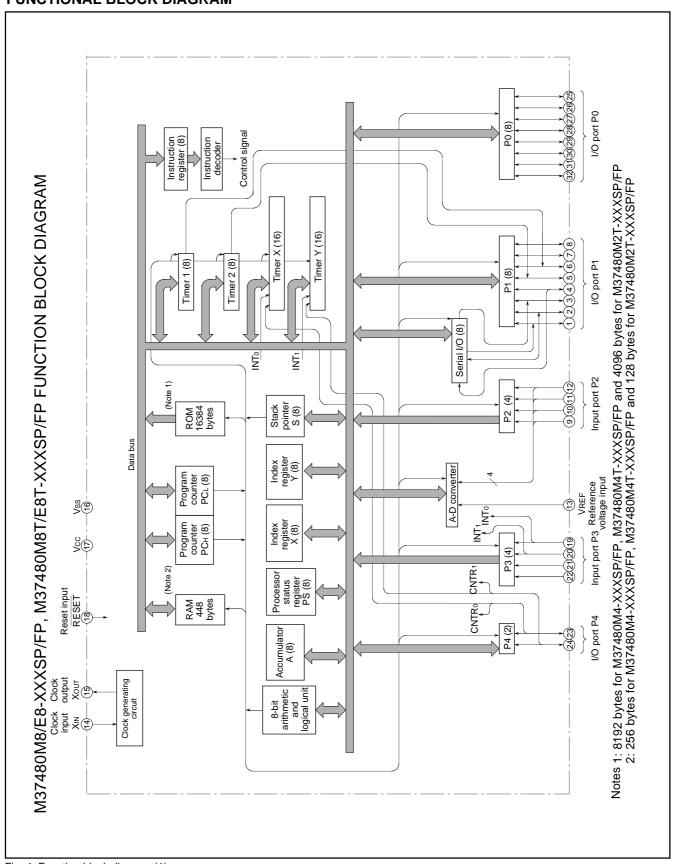
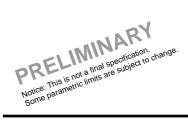


Fig. 4 Function block diagram (1)



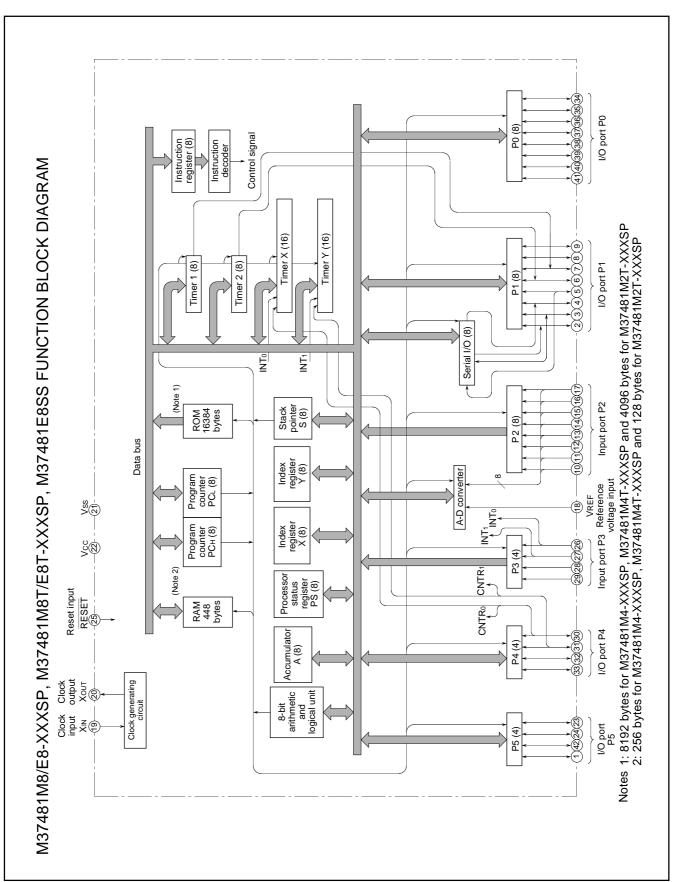


Fig. 5 Function block diagram (2)





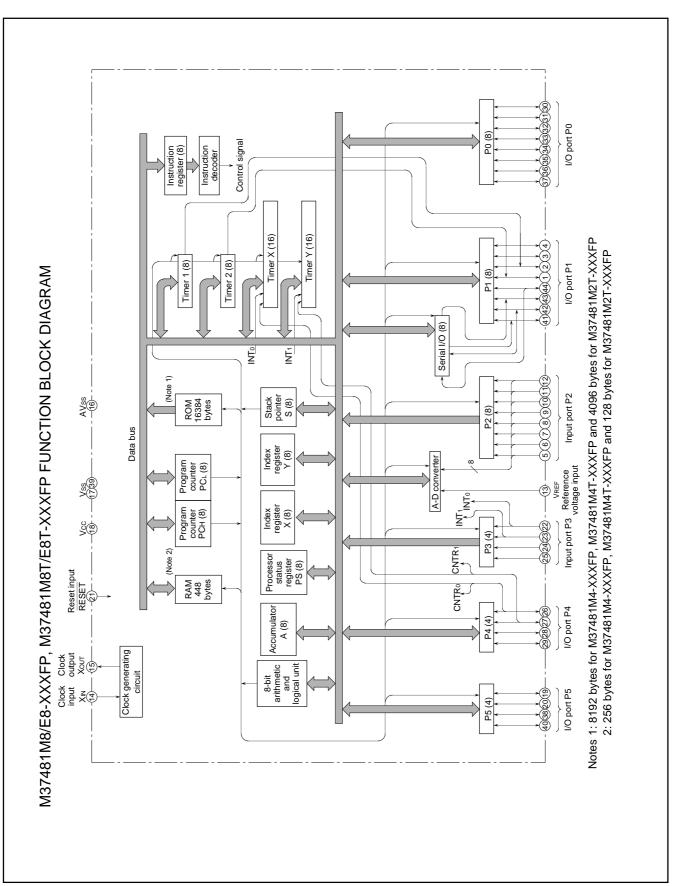
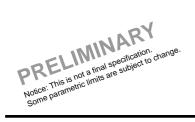


Fig. 6 Function block diagram (3)







FUNCTIONS OF 7480/7481 GROUP

Table 2. Functions of 7480/7481 group

Parameter			Functions			
			M37480M4/M8/E8-XXXSP/FP M37481M4/M8/E8-XXXSI			
			M37480M2T/M4T/M8T/E8T-XXXSP/FP	M37481M2T/M4T/M8T/E8T-XXXSP/FP		
Number of basic instr	uctions		71 (740 family 69 basic instructions + 2 multiplication/division instructions)			
Instruction execution	time		0.5µs (Minimum instructions, at 8 MHz clock input oscillation frequency)			
Clock input oscillation frequency			8 MHz (max.)			
		M8/E8	16384 bytes			
	ROM	M4	8192 bytes			
M		M2	4096 bytes			
Memory size		M8/E8	448 bytes			
	RAM	M4	256 bytes			
		M2	128 bytes			
	P0, P1	I/O	8 bits	s X 2		
	P2	Input	4 bits X 1	8 bits X 1		
I/O port	P3	Input	4 bits X 1			
	P4	I/O	2 bits X 1	4 bits X 1		
	P5	I/O		4 bits X 1		
1/0 ah aya ata ziati a	I/O withst	and voltage	5 V			
I/O characteristics Output current		-5 to 10 mA (P0, P1: CMOS tri-states), 10 mA (P4, P5: N channel)				
Serial I/O	'		8 bits X 1			
Timers			16-bit timer x 2, 8-bit timer x 2			
		M8/E8	192 max.			
Subroutine nesting		M4	96 max.			
		M2	64 max.			
Interrupt			5 external interrupts, 8 internal interrupts, 1 software interrupt			
			8 bits X 4 analog inputs	8 bits X 8 analog inputs		
A-D converter (successive comparison method)		(in common with P2)	(in common with P2)			
Clock generating circuit			Built-in circuit with feedback resistor (with external ceramic oscillator)			
Watchdog timer			Built-in circuit			
Power source voltage		2.7 to 4.5 V (at f(XIN) = (2.2Vcc - 2) MHz)				
		4.5 to 5.5 V (at f(XIN)=8 MHz)				
Power dissipation			35 mW (standard, at 8 MHz clock input oscillation frequency)			
Operating temperature range			-20 to 85 °C (-40 to 85 °C for extended operating temperature range version)			
Device structure			CMOS silicon gate			
Package			32-pin SDIP/32-pin SOP	42-pin SDIP/44-pin OFP		







SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

PIN DESCRIPTION

Table 3. Pin description

Pin	Name	Input/ output	Functions	
Vcc, Vss	Power source		Apply a voltage of 2.7 to 5.5 V to Vcc and 0 V to Vss.	
AVss	Analog power source input		Ground level input pin for A-D converter. Apply the same voltage as Vss. (The pin is for 44P6N-A package only.)	
VREF	Reference voltage input	Input	Reference voltage input pin for A-D converter. (When the A-D converter is no used, connect it to Vcc.)	
RESET	Reset input	Input	Reset input pin active "L".	
XIN	Clock input	Input	These are I/O pins for the internal clock generating circuit of the main clock. To control the generating frequency, an external ceramic is connected between the XIN and XOUT pins. If an external clock is used, the clock source should be	
Хоит	Clock output	Output	connected to the XIN pin, and the XOUT pin should be left open. The feedback resistor is connected between XIN and XOUT.	
P00 – P07	I/O port P0	I/O	8-bit I/O port. The output structure is CMOS output. When this port is selected for input, pull-up transistors can be connected units of 1 bit, and a key-on wake-up function is provided.	
P10 – P17	I/O port P1	I/O	8-bit I/O port. The output structure is CMOS output. When this port is selected for input, pull-up transistors can be connected units of 4 bits. P12 and P13 are in common with timer output pins To and P14, P15, P16 and P17 are in common with serial I/O pins RxD, TxD, Sclk a SRDY, respectively.	
P20 – P27	Input port P2	Input	8-bit input port. (Only 4 bits of P20 to P23 for the 7480 group) or analog in pins INo to IN7 (INo to IN3 for the 7480 group).	
P30 – P33	Input port P3	Input	4-bit input port. P3o and P31 can be configured to serve as external interrup input pins INTo and INT1.	
P40 – P43	I/O port P4	I/O	4-bit I/O port. (2 bits of P40 and P41 for the 7480 group). The output structur is N-channel open drain output, having a built-in clamp diode. P40 and P41 ca be configured to serve as timer I/O pins CNTR0 and CNTR1.	
P50 – P53	I/O port P5	I/O	4-bit I/O port. (This port is not included in the 7480 group.) The output structure is N-channel open drain output, having built-in clamp diodes.	



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

FUNCTIONAL DESCRIPTION Central Processing Unit (CPU)

The 7480/7481 group uses the standard 740 family CPU. Refer to the table of 740 family addressing modes and machine instructions or the MELPS 740 programming manual for details on the instruction set.

Machine-resident 740 family instructions are as follows:

- 1. The FST and SLW instructions are not available.
- 2. The MUL and DIV instructions are available.
- 3. The WIT instruction is available. (Note)
- 4. The STP instruction is available. (Note)

Note: When using these instructions, refer to the corresponding chapter "STP and WIT instruction control" below.

CPU Mode Register

The stack page selection bit is assigned to the CPU mode register. This register is allocated at address 00FB16.

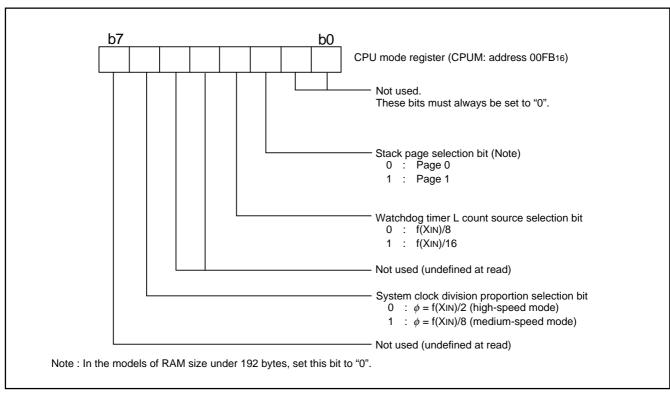


Fig. 7 Structure of CPU mode register



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

Memory

• SFR Area

This SFR area is provided in the zero page and contains the registers for controlling I/O ports and timers.

• RAM

RAM is used for data storage and for calling subroutines, as well as for a stack area for interrupts.

• ROM

ROM is used for storing user programs and interrupt vectors.

• Interrupt Vector Area

The interrupt vector area is used for storing vector addresses when an interrupt is generated or at reset.

Zero Page

This area can be accessed with 2 words when the zero page addressing mode is used.

· Special Page

This area can be accessed with 2 words when the special page addressing mode is used.

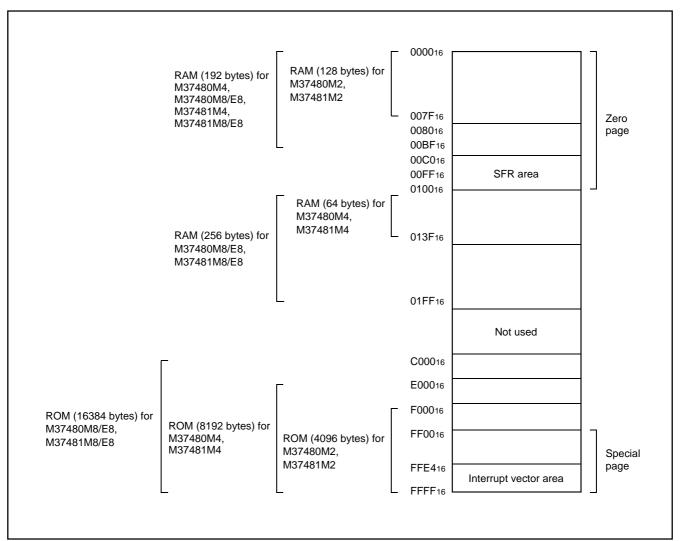
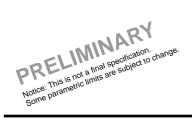


Fig. 8 Memory map





00C016	Port P0 (P0)	00E016	Transmit/receive buffer register (TB/RB)
00C116	Port P0 direction register (P0D)	00E1 ₁₆	Serial I/O status register (SIOSTS)
00C216	Port P1 (P1)	00E216	Serial I/O control register (SIOCON)
00C3 ₁₆	Port P1 direction register (P1D)	00E316	UART control register (UARTCON)
00C416	Port P2 (P2)	00E416	Baud rate generator (BRG)
00C516		00E516	Bus collision detection control register (BUSARBCON
00C616	Port P3 (P3)	00E616	
00C716		00 E7 16	
00C916	Port P4 (P4)	00E816	
00C916	Port P4 direction register (P4D)	00E916	
00CA ₁₆	Port P5 (P5) (Note)	00EA16	
00CB ₁₆	Port P5 direction register (P5D) (Note)	00EB16	
00CC16		00EC16	
00CD16		00ED16	
00CE16		00EE16	
00CF ₁₆		00EF16	Watchdog timer H (WDTH)
00D016	Port P0 pull-up control register (P0PCON)	00F016	Timer X low-order (TXL)
00D116	Port P1 pull-up control register (P1PCON)	00F1 ₁₆	Timer X high-order (TXH)
00D216	Port P4P5 input control register (P4P5CON)	00F216	Timer Y low-order (TYL)
00D316		00F3 ₁₆	Timer Y high-order (TYH)
00D416	Edge polarity selection register (EG)	00F416	Timer 1 (T1)
00D516		00F516	Timer 2 (T2)
00D616		00F616	Timer X mode register (TXM)
00D716		00F7 ₁₆	Timer Y mode register (TYM)
00D816		00F816	Timer XY control register (TXYCON)
00D916	A-D control register (ADCON)	00F9 ₁₆	Timer 1 mode register (T1M)
00DA ₁₆	A-D conversion register (AD)	00FA ₁₆	Timer 2 mode register (T2M)
00DB16		00FB ₁₆	CPU mode register (CPUM)
00DC16		00FC16	Interrupt request register 1 (IREQ1)
00DD16		00FD16	Interrupt request register 2 (IREQ2)
00DE16	STP instruction operation control register (STPCON)	00FE16	Interrupt control register 1 (ICON1)
00DF16		00FF16	Interrupt control register 2 (ICON2)

Fig. 9 SFR (Special Function Register) memory map

Note: This port is not allocated in the 7480 group.







I/O Ports

[Direction Registers]

The I/O ports have direction registers which determine the input/output direction of each pin in units of bit. When a bit of the direction register is set to "1", the corresponding pin becomes an output port. When the bit is cleared to "0", it becomes an input port.

If data is read from a pin configured as output, the value of the port latch is read rather than the value of this pin.

A pin configured as input becomes floating and its value can be read. If data is written to a pin, it is written to the port latch, but the pin remains floating.

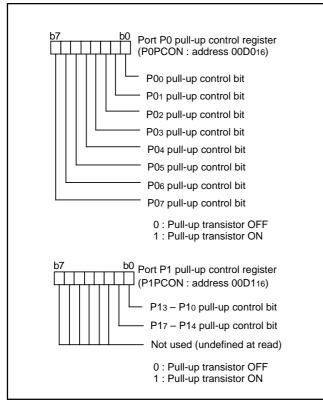


Fig. 10 Structure of pull-up control register

[Pull-up Control Registers]

Ports P0 and P1 are provided with a programmable pull-up transistor. When "1" is written to the pull-up control register and the direction register is in the input mode, the pull-up transistor turns on, and the port is pulled up.

■ Notes on Use for STP Instruction

When the 7480/7481 group is executing an STP instruction, apply 0 V or the same voltage as Vcc to the following pins.

If an intermediate voltage is applied to these pins, a through-current flows to the input gates and the power current increases. P4, P5, P3, P16, P14

[Port P4P5 Input Control Register]

When ports P42, P43 and P5 of the 7481 group are selected for input, clear the corresponding direction register to "0" and set "1" to the corresponding bit of the port P4P5 input control register.

Ports P42, P43 and P5 are not included in the 7480 group. Fix each bit of the port P4P5 input control register to "0".

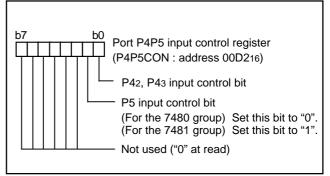


Fig. 11 Structure of port P4P5 input control register



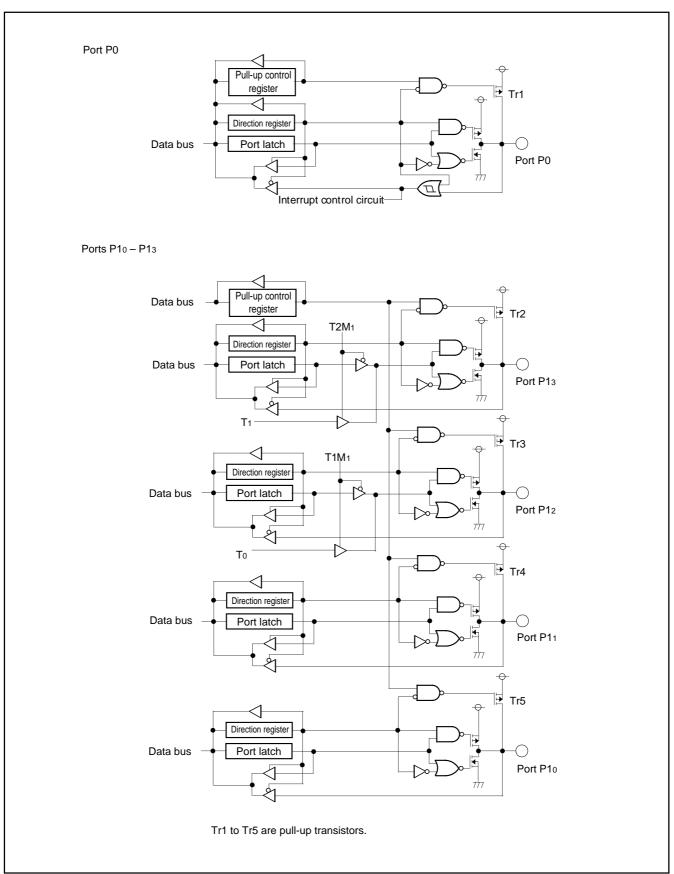


Fig. 12 Block diagram of ports (1)





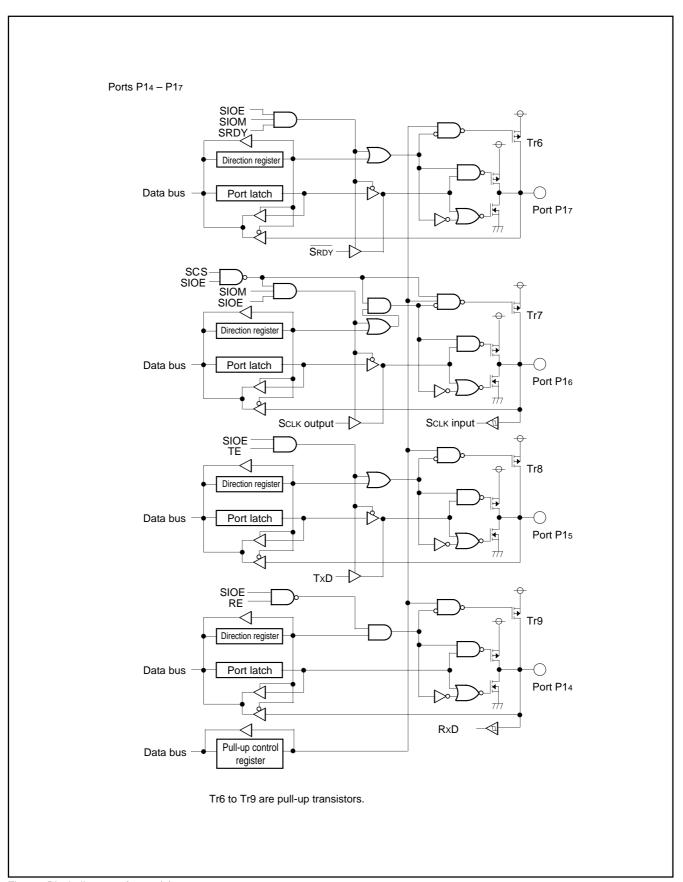


Fig. 13 Block diagram of ports (2)





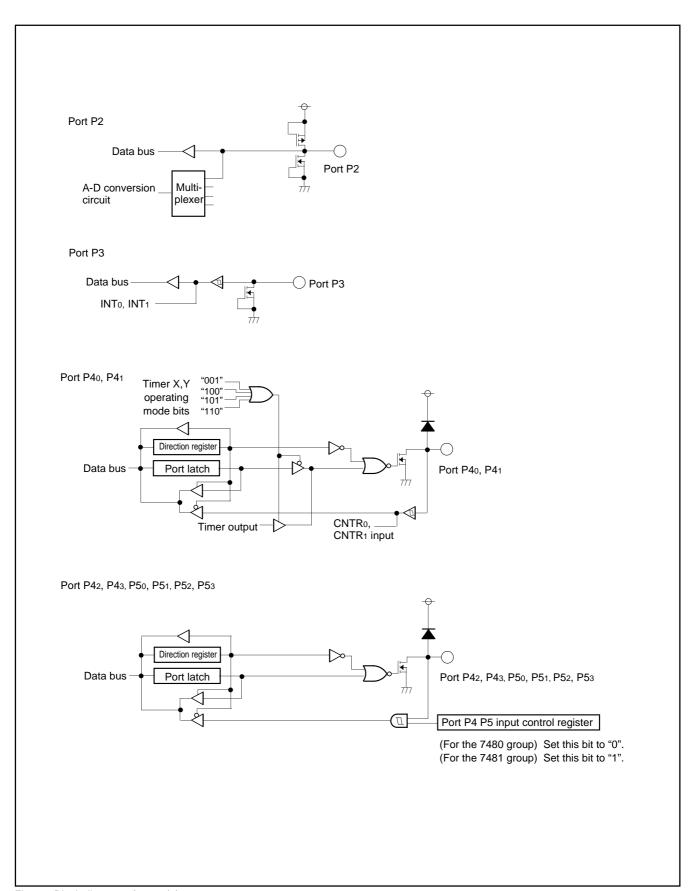


Fig. 14 Block diagram of ports (3)



MITSUBISHI MICROCOMPUTERS

7480/7481 GROUP



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

Interrupts

Interrupts are vectored interrupts, and they can be caused by 14 different sources: 5 external sources, 8 internal sources, and 1 software source.

(1) Interrupt Control

All interrupts, except the BRK instruction interrupt, have an interrupt request bit and an interrupt enable bit. Additionally, a global interrupt disable flag affects them.

When the interrupt enable bit and the interrupt request bit are set to "1" and the interrupt disable flag is set to "0", an interrupt is accepted.

The interrupt request bits can be cleared by the program but cannot be set. The interrupt enable bit can be set and cleared by the program.

The reset and BRK instruction interrupt can never be disabled. Other interrupts are disabled when the interrupt disable flag is set.

(2) Interrupt Operation

When an interrupt request is accepted:

- The contents of the program counter and the processor status register are automatically pushed into the stack.
- 2. The interrupt disable flag is set and the interrupt request bit is cleared.
- 3. The interrupt jump destination address is read into the program counter.

■ Notes

- When the active edge of an external interrupt (INT0, INT1, CNTR0, CNTR1) is set, the interrupt request bit may also be set. Therefore, disable the external interrupt and set the edge polarity selection register. Then clear the interrupt request bit and accept the external interrupt.
- Input a trigger width over 250 ns to the INTo/INT1 pin.



Table 4. Interrupt vector addresses and priority

latare est access	Prior- ity	Vector address (Note 1)		late and the second sec	Damaria
Interrupt source		High-order	Low-order Interrupt request generating conditions		Remarks
RESET (Note 2)	1	FFFF16	FFFE16	At reset	Non-maskable
INT ₀	2	FFFD16	FFFC16	At detection of either rising edge or falling edge of INTo input	External interrupt (active edge programmable)
INT ₁	_		FFFA16	At detection of either rising edge or falling edge of INT1 input	External interrupt (active edge programmable)
Key-on wake-up	3	FFFB16		At input "L" to port P0 in key-on wake-up mode	Validity after execution of STP/WIT instruction
CNTR ₀	4	FFF916	FFF816	At detection of either rising edge or falling edge of CNTRo input	External interrupt (active edge programmable)
CNTR ₁	5	FFF716	FFF616	At detection of either rising edge or falling edge of CNTR1 input	External interrupt (active edge programmable)
Timer X	6	FFF516	FFF416	At timer X underflow	
Timer Y	7	FFF316	FFF216	At timer Y underflow	
Timer 1	8	FFF116	FFF016	At timer 1 underflow	
Timer 2	9	FFEF16	FFEE16	At timer 2 underflow	
Serial I/O reception	10	FFED16	FFEC16	At completion of serial I/O data reception	
Serial I/O transmission	11	FFEB16	FFEA ₁₆	At completion of serial I/O transfer shift or when transmission buffer is empty	
Bus arbitration	12	FFE916	FFE816	At detection of bus collision	
A-D conversion	13	FFE716	FFE616	At completion of A-D conversion	
BRK instruction	14	FFE516	FFE416	At execution of BRK instruction	Non-maskable software interrupt

Notes 1: Vector addresses contain interrupt jump destination addresses.

2: RESET is mentioned in the table because its operation is the same as an interrupt.

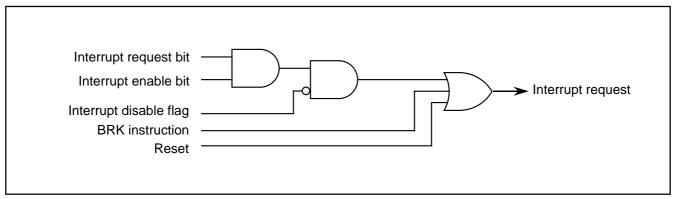


Fig. 15 Interrupt control diagram





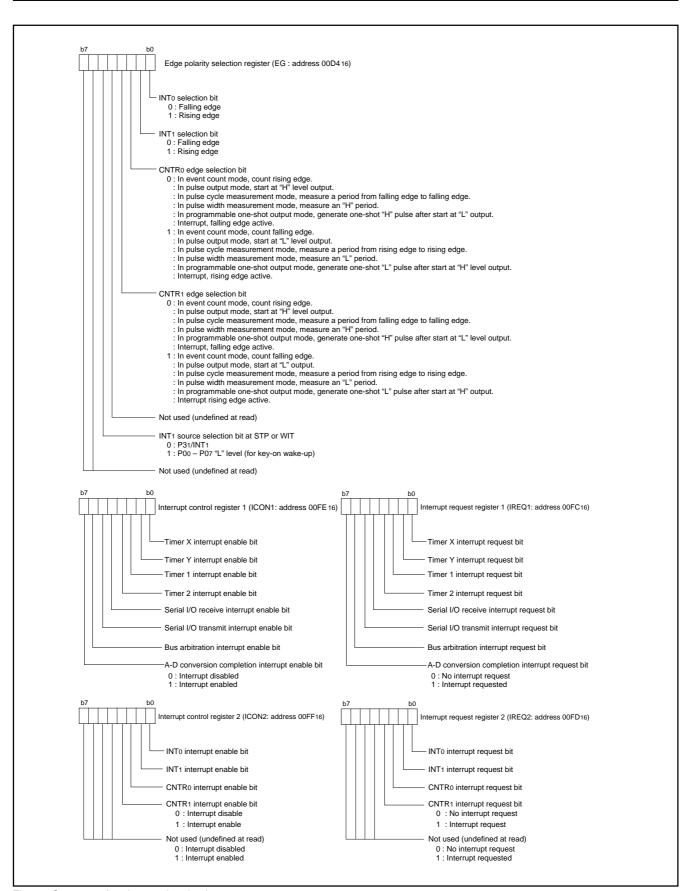
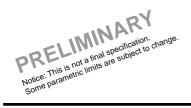


Fig. 16 Structure of registers related to interrupts





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

Timers

The 7480/7481 group has two 16-bit timers (timer X and timer Y), and two 8-bit timers (timer 1 and timer 2).

All the timers are of a count-down type. When the timer reaches "FF16" or "000016", an underflow occurs at the next count pulse and the corresponding timer latch is reloaded into the timer and the count is continued. When a timer underflows, the interrupt request bit corresponding to this timer is set to "1".

At reading and setting the timer value to a 16-bit timer, be sure to read and set both high-order byte and low-order byte.

At reading the count value from a 16-bit timer, read the high-order byte and the low-order byte in this order. At setting the count value in a 16-bit timer, set the low-order byte and the high-order byte in this order.

The 16-bit timer cannot operate normally at reading during set operation or at setting during read operation.

• Timer X, Timer Y

Both timer X and timer Y are 16-bit timers independent from each other. They can select 7 operating modes by setting the mode registers. The registers related to timer X and timer Y are shown below. In the following, abbreviations will be used as register names.

- Timer XY control register (TXYCON: address 00F816)
- Port P4 direction register (P4D: address 00C916)
- Timer X low-order (TXL: address 00F016)
- Timer X high-order (TXH: address 00F116)
- Timer Y low-order (TYL: address 00F216)
- Timer Y high-order (TYH: address 00F316)
- Timer X mode register (TXM: address 00F616)
- Timer Y mode register (TYM: address 00F716)
- Edge polarity selection register (EG: address 00D416)
- Interrupt request register 1 (IREQ1: address 00FC16)
- Interrupt request register 2 (IREQ2: address 00FD16)
- Interrupt control register 1 (ICON1: address 00FE16)

• Interrupt control register 2 (ICON2: address 00FF16)

For register structures, refer to each register structural diagram. In the following, each mode will be described.

(1) Timer Mode/Event Count Mode

① Timer Mode

Mode Selection

This mode is selected by setting "000" in the timer X operating mode bits (b2b1b0) of TXM and the timer Y operating mode bits (b2b1b0) of TYM.

Count Source Selection

The count source is f(XIN)/2, f(XIN)/8 or f(XIN)/16.

Interrupt

When a timer underflows, the timer X interrupt request bit (b0) or timer Y interrupt request bit (b1) of IREQ1 is set to "1".

Explanation of Operation

by setting "0" in b0 or b1 of TXYCON.

After reset release, the timer X stop control bit (b0) or timer Y stop control bit (b1) of TXYCON is "1", and the timer stops. In the timer stop status, usually the timer value is set by writing the latch and timer at the same time. Timer operation is started

When the timer reaches "000016", an underflow occurs at the next count pulse, the corresponding timer latch is reloaded into the timer, and the count is continued. To change the timer value during count operation, the latch value is changed by writing to

the latch only. At the next underflow reloading, the timer value is changed.

2 Event Count Mode

Mode Selection

Select the timer event count mode. This mode is selected by inputting from the CNTR0 pin for timer X or from the CNTR1 pin for timer Y (setting "11" in b7 and b6 of TXM or "11" in b7 and b6 of TYM). The count operation active edge is selected by setting in the CNTR0 edge selection bit (b2) or the CNTR1 edge selection bit (b3) of EG. At "0", the rising edge is counted.

At "1", the falling edge is counted.

Interrupt

The underflow interrupt is the same as the timer mode.

Explanation of Operation

This operation is the same as that of the timer mode. In this mode, set the port in common with the CNTR₀/CNTR₁ pin as an input port.

Figure 19 shows a timing diagram in the timer event count mode.

(2) Pulse Output Mode

Mode Selection

This mode is selected by setting b2, b1 and b0 of TXM or TYM to "001".

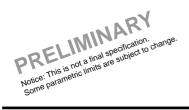
Count Source Selection

The count source is f(XIN)/2, f(XIN)/8 or f(XIN)/16.



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Interrupt

The timer underflow interrupt is the same as the timer event count mode.

Explanation of Operation

This operation is the same as the timer event count mode except that a timer outputs a pulse from the CNTRo/CNTR1 pin in which the polarity of output level is inverted at each timer underflow. When the CNTRo edge selection bit (b2) or CNTR1 edge selection bit (b3) of EG is "0", the output of the CNTRo/CNTR1 pin is started with an "H" level output. When b2 or b3 of EG is "1", the output of this pin is started with an "L" level. In this mode, set the port in common with the CNTRo/CNTR1 pin as an output port.

■ Note

While a timer operation stops

The output level of the CNTR0/CNTR1 pin is initialized to the value set in the CNTR0 edge selection bit or CNTR1 edge selection bit by writing to the timer.

While a timer operation is enabled

The output level of the CNTR0/CNTR1 pin is inverted by changing the CNTR0 edge selection bit or CNTR1 edge selection bit.

Figure 20 shows a timing diagram in the pulse output mode.

(3) Pulse Cycle Measurement Mode

Mode Selection

This mode is selected by setting b2, b1 and b0 of TXM or TYM to "010".

Count Source Selection

The count source is f(XIN)/2, f(XIN)/8 or f(XIN)/16.

Interrupt

The underflow interrupt is the same as the timer event count mode. Set b2 or b3 of IREQ2 to "1" as soon as the pulse cycle measurement is completed.

Explanation of Operation

While a timer operation stops

Select a timer count source. Next, select a pulse cycle to be measured. When b2 or b3 of EG is "0", a timer counts a period from a falling edge to a falling edge of the CNTR₀/CNTR₁ pin input.

When b2 or b3 of EG is "1", a timer counts a period from a rising edge to a rising edge of the CNRTo/CNTR1 pin input.

While a timer operation is enabled

At setting b0 and b1 of TXYCON to "0", a timer starts to measure the pulse cycle, and starts to count down from the count value provided before measurement. When an active edge is detected at measurement completion or measurement start, 1's complement of the timer value is set to the timer latch and "FFFF16" is set in the timer.

When a timer underflows, a timer X or timer Y interrupt occurs, and "FFFF16" is set in the timer. A measurement value is held until the next measurement is completed. In this mode, set the port in common with the CNTRo/CNTR1 pin as an input port.

■ Note

The timer value cannot be read in this mode. A timer value can be set while a timer operation stops (no measurement).

Since the timer latch of this mode becomes read only, do not perform a write operation during measurement.

The timer is set to "FFFF16" only when the timer underflows or the active edge of pulse cycle measurement is detected.

Accordingly, the timer value at a start of measurement depends on

the timer value provided before the start of measurement.

Figure 21 shows a timing diagram in the pulse cycle measurement mode.

(4) Pulse Width Measurement Mode

Mode Selection

This mode is selected by setting b2, b1 and b0 of TXM or TYM to "011".

Count Source Selection

The count source is f(XIN)/2, f(XIN)/8 or f(XIN)/16.

Interrupt

The underflow interrupt is the same as the timer event count mode. Set b2 or b3 of IREQ2 to "1" as soon as pulse width measurement is completed.

Explanation of Operation

While a timer operation stops

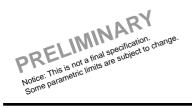
Select a timer count source. Next, select a pulse width to be measured. A timer counts a period from a falling edge to a rising edge of the CNTR0/CNTR1 pin input ("L" period) when b2 or b3 of EG is "1". A timer counts a period from a rising edge to a falling edge of the CNTR0/CNTR1 pin input ("H" period) when b2 or b3 of EG is set to "0".

While a timer operation is enabled

At setting b0 and b1 of TXYCON to "0", a timer starts to measure a pulse width, and starts to count down from the count value provided before measurement. When the active edge is detected at measurement completion, 1's complement of the timer value is set in the timer latch. When the active edge is detected at measurement completion or measurement start, "FFFF16" is set in the timer. When a timer underflows, a timer X or timer Y interrupt occurs, and "FFFF16" is set in the timer.

A measurement value is held until the next measurement is completed. In this mode, set the port in common with the CNTRo/CNTR1 pin as an input port.





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■ Note

The timer value cannot be read in this mode. A timer value can be set while a timer operation stops (not under pulse width measurement).

Since the timer latch of this mode becomes read only, do not perform a write operation during measurement.

The timer is set to "FFFF16" only when a timer underflows or when the active edge of pulse width measurement is detected.

Accordingly, the timer value at a start of measurement depends on the timer value provided before the start of measurement.

Figure 22 shows a timing diagram in the pulse width measurement mode.

(5) Programmable Waveform Generation Mode

Mode Selection

This mode is selected by setting b2, b1 and b0 of TXM or TYM to "100".

Count Source Selection

The count source is f(XIN)/2, f(XIN)/8 or f(XIN)/16.

Interrupt

The underflow interrupt is the same as the timer event count mode. The INTo interrupt request bit (b0) or INT1 interrupt request bit (b1) of IREQ2 is set to "1" by detecting an active edge of the INT pin.

Explanation of Operation

This operation is the same as that of the timer event count mode, except that a timer outputs the level of the value set in the output level latch (b4) of TXM or TYM from the CNTR0/CNTR1 pin each time the timer underflows. After the timer underflows, if the values of the output level latch and timer latch are changed, the timer can output an optional waveform from the CNTR0/CNTR1 pin. In this mode, set the port in common with the CNTR0/CNTR1 pin as an output port.

In this mode, if the trigger selection bit of TXM or TYM is set to "1" and the count stop control bit of TXYCON is set to "0" (count operation), a timer can be started concurrently with the occurrence of a trigger (input signal of INTo/INT1 pin).

A timer starting trigger is set in the INTo edge selection bit (b0) or INT1 edge selection bit (b1) of EG. At "0", the falling edge is active. At "1", the rising edge is active. When the count stop control bit is "1" (count status), a timer is not started at the occurrence of a trigger.

Figure 23 shows a timing diagram in the programmable waveform generation mode.

(6) Programmable One-Shot Output Mode

Mode Selection

This mode is selected by setting b2, b1 and b0 of TXM or TYM to "101".

Count Source Selection

The count source is f(XIN)/2, f(XIN)/8 or f(XIN)/16.

Interrupt

The underflow interrupt is the same as the timer event count mode. One-shot output trigger is set in the INTo edge selection bit (b0) or INT1 edge selection bit (b1) of EG. At "0", the falling edge is active. At "1", the rising edge is active. The INTo interrupt request bit (b0) or INT1 interrupt request bit (b1) of IREQ2 is set to "1" by detecting an active edge of the INT pin.

Explanation of Operation

① In case of One-shot Output "H"

(b2, b3 of EG = "0")

While a timer operation stops

The output level of the CNTR0/CNTR1 pin is initialized to "L" at mode selection. Set the one-shot width in TXH, TXL, TYH and TYL. While a timer operation stops, a trigger (input signal of INT0/INT1 pin) cannot occur.

While a timer operation is enabled

At detecting a trigger, a timer outputs "H" from the CNTR₀/CNTR₁ pin, and outputs "L" at a timer underflow.

② In Case of One-shot Output "L"

(b2, b3 of EG = "1")

While a timer operation stops

The output level of the CNTRo/CNTR1 pin is initialized to "H" at mode selection. Set the one-shot width in TXH, TXL, TYH and TYL. While a timer operation stops, a trigger (input signal of the INTo/INT1 pin) cannot occur.

While a timer operation is enabled

At the detection of a trigger, a timer outputs "L" from the CNTR₀/CNTR₁ pin and outputs "H" at a timer underflow.

In this mode, set the port in common with the CNTR₀/CNTR₁ pin as an output port.

■ Note

- Input a trigger width over 250 ns to the INTo/INT1 pin.
- If the value of the CNTRo edge selection bit or CNTR1 edge selection bit is changed while one-shot output is enabled or one-shot output occurs, the output level from the CNTRo/ CNTR1 pin changes.

Figure 24 shows a timing diagram in the programmable oneshot output mode.





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(7) PWM Mode

Mode Selection

This mode is selected by setting b2, b1 and b0 of TXM or TYM to "110".

Count Source Selection

The count source is f(XIN)/2, f(XIN)/8 or f(XIN)/16.

Interrupt

At the rising edge of the CNTR0/CNTR1 output, set the timer X interrupt request bit (b0) or timer Y interrupt request bit (b1) of IREQ1 to "1".

Explanation of Operation

In the case of timer X, the PWM waveform is output from the CNTR₀ pin. In the case of timer Y, the PWM waveform is output from the CNTR₁ pin.

The PWM waveform "H" period is determined by the setting value n (n=0 to 255) of TXH or TYH. The "L" period is determined by the setting value m (m=0 to 255) of TXL or TYL. The PWM cycle is as follows:

PWM cycle = $(n + m) \times ts$

PWM output duty =
$$\frac{n}{(n + m)}$$

ts: Timer X/timer Y count source cycle

While a timer operation stops

The timer value is set in TXL, TXH, TYL and TYH by writing to the timer and timer latch at the same time. The output of the CNTR0/CNTR1 pin is initialized to "H" by setting this timer value. While a timer operation is enabled

When b1 and b0 of TXYCON are set to "0", "H" is output during the period of the setting value of TXH or TYH. After that, "L" is output during the period of the setting value of TXL or TYL.

Then, these operations will be repeated. The PWM output subsequent to an underflow can be changed by setting the timer value in TXL, TXH, TYL, TYH by writing only to the timer latch. In this mode, set the port in common with the CNTR0/CNTR1 pin as an output port.

■ Note

- When the PWM "H" period is set to "0016", the PWM output is always "L" level.
- When the PWM "L" period is set to "0016", the PWM output is always "H" level.
- When the PWM "H" period is set to "0016" and the "L" period is set to "0016", the PWM output is always "L" level.
- When at least one of the PWM "H" period and "L" period is set to "0016", a timer X interrupt request/timer Y interrupt request does not occur.
- When the timer latch is set at "0016", the timer counts down, so its value is not constant.

Figure 25 shows a timing diagram in the PWM mode.

■ Note on All Modes

Write Control for Timer X, Timer Y

Timer X and timer Y can select either writing to both timer latch and timer or writing only to the timer latch by b3 of TXM or TYM. At writing only to the timer latch, a value is set in the timer latch by writing the value in the timer X/timer Y address, so the timer is updated at the next underflow. After reset release, writing to both the timer latch and timer is selected.

At this status, when a value is written in the timer X/timer Y address, the value is set in both the timer and timer latch at the

same time.

At writing only to the timer latch, when the write timing for the timer latch is almost equal to the underflow timing, the value that is set in the timer may not be constant.

Read Control for Timer X/Timer Y

When the pulse cycle measurement mode or pulse width measurement mode is selected, the timer value cannot be read out. In the other modes, the timer value can be read regardless of count operation and count stop. However, the timer latch value cannot be read out.

 Note on CNTR0, CNTR1, INT0, INT1 Interrupt Polarity Selection When the CNTR0/CNTR1 edge selection bit or INT0/INT1 interrupt edge selection bit is set, this affects the respective interrupt polarity.





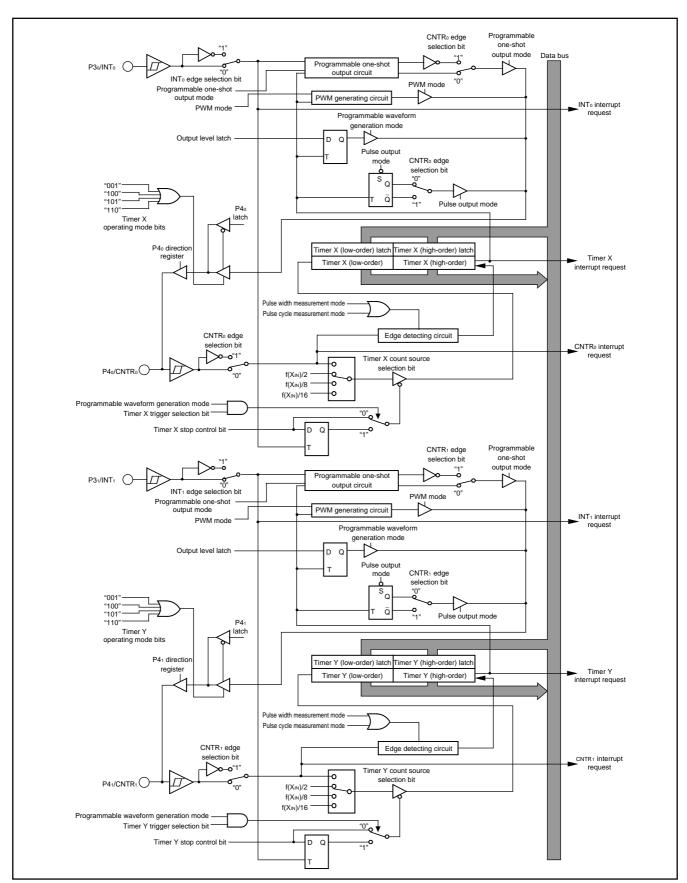


Fig. 17 Block diagram of timer X and timer Y





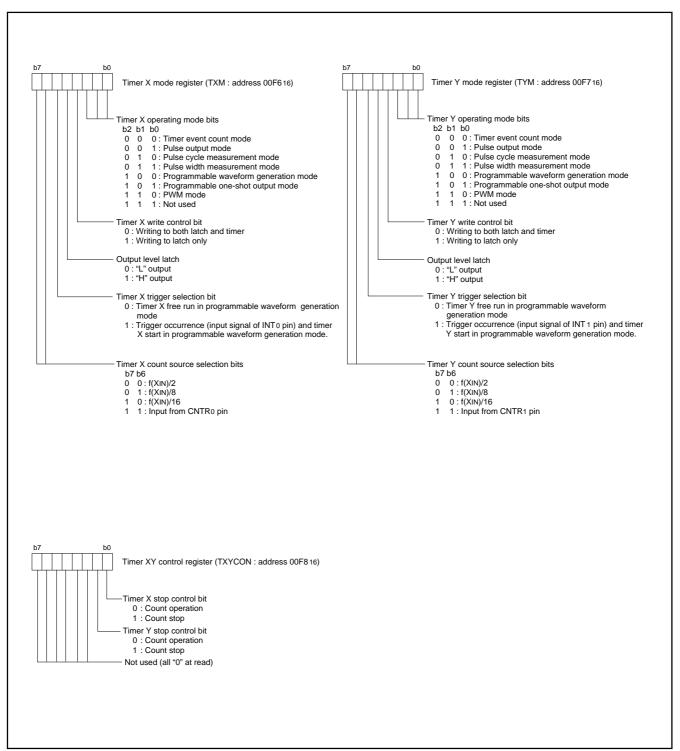
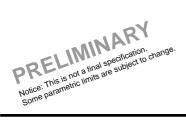


Fig. 18 Structure of timer X/timer Y mode register and timer XY control register





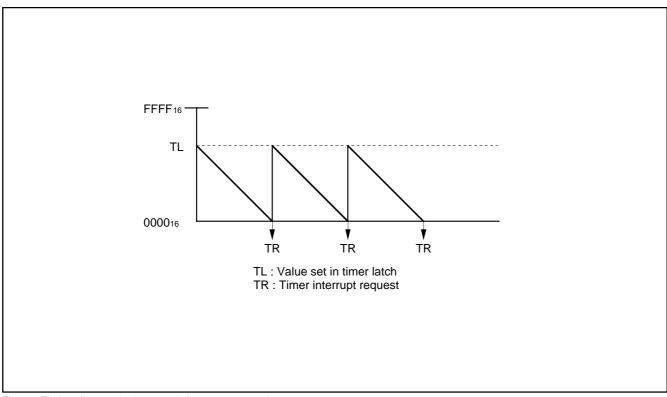


Fig. 19 Timing diagram in timer mode/event count mode

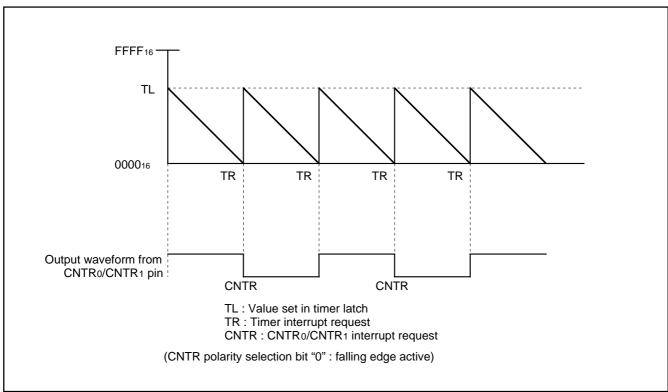


Fig. 20 Timing diagram in pulse output mode





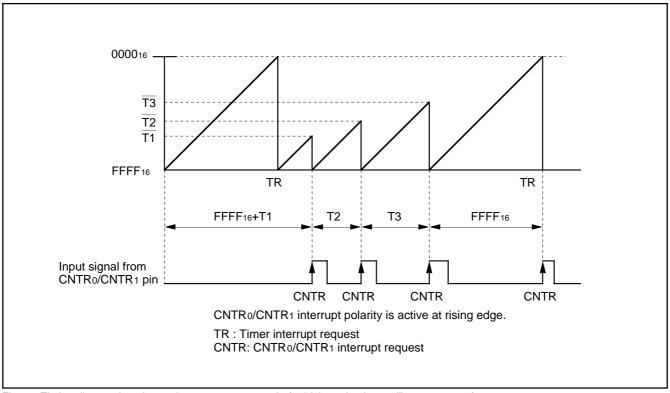


Fig. 21 Timing diagram in pulse cycle measurement mode (at "rising edge interval" measurement)

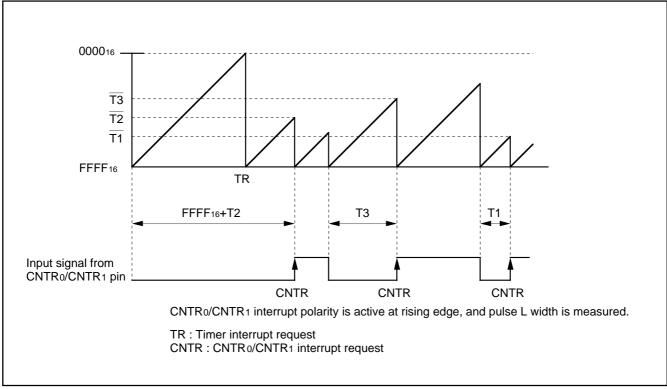
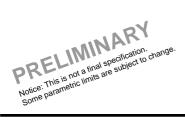


Fig. 22 Timing diagram in pulse width measurement mode (at "L section" measurement)





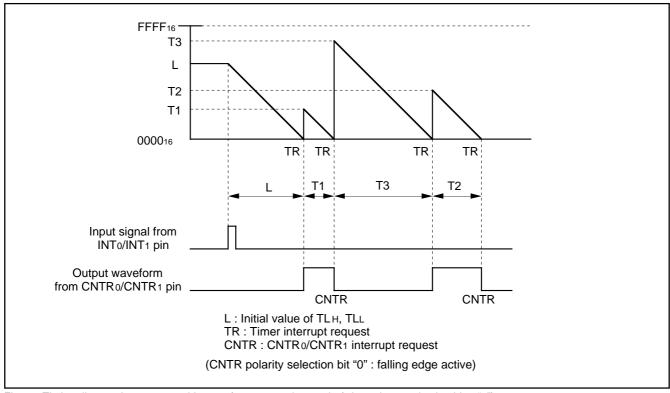


Fig. 23 Timing diagram in programmable waveform generation mode (when trigger selection bit = "1")

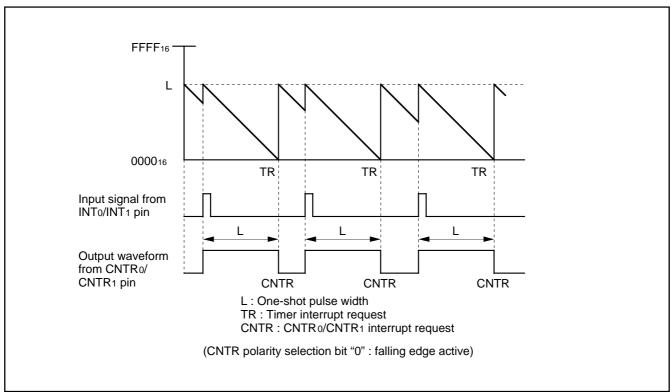


Fig. 24 Timing diagram in programmable one-shot output mode





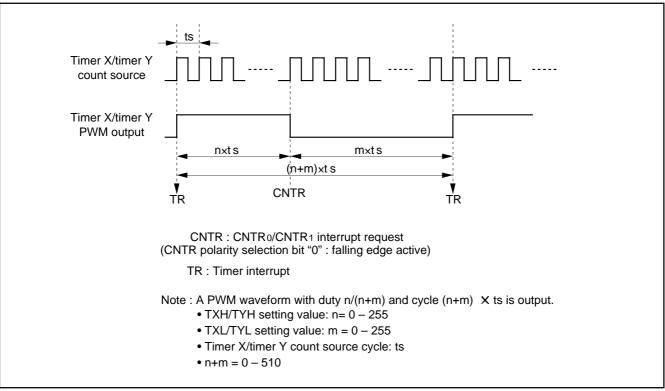


Fig. 25 Timing diagram in PWM mode



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Timers 1 and 2

Timer 1 and timer 2 are the 8-bit timers. They can select the following 2 modes by setting timer 1 mode register and timer 2 mode register.

- Timer mode
- Programmable waveform generation mode

When the count source is changed, set it again as the timer value may go wrong.

(1) Timer Mode

The frequency of f(XIN)/8, f(XIN)/64, f(XIN)/128 or f(XIN)/256 is counted.

(2) Programmable Waveform Generation Mode

This operation is the same as the timer mode, except that a timer outputs the level of the value set in the output level latch of the timer 1 mode register/timer 2 mode register from the To or T1 pin each time a timer underflows.

After the timer underflows, the timer can output an optional waveform from the T_0 or T_1 pin if the values of the output level latch and timer latch are changed.

In this mode, set the port in common with the T_0/T_1 pin as an output port.

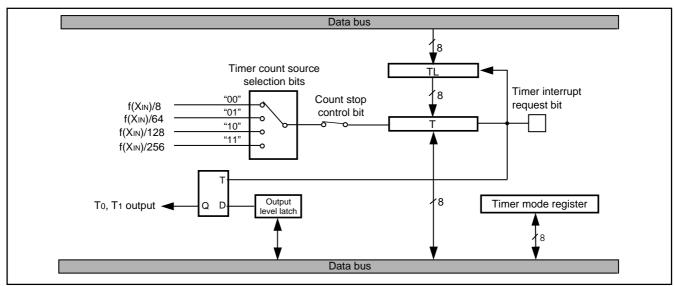


Fig. 26 Block diagram of timer 1, timer 2

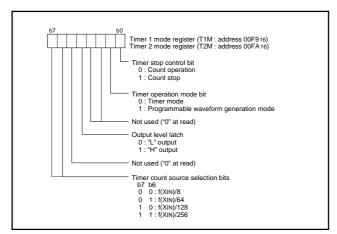
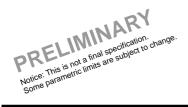


Fig. 27 Structure of timer 1/timer 2 mode register





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Serial I/O

Serial I/O can be used as either clock synchronous or asynchronous (UART) serial I/O. A dedicated timer (baud rate generator) is also provided for baud rate generation when serial I/O is in operation.

(1) Clock Synchronous Serial I/O Mode

The clock synchronous serial I/O mode can be selected by setting

the serial I/O mode selection bit of the serial I/O control register (address 00E216) to "1".

In the clock synchronous serial I/O, the transmitter-side microcomputer and the receiver-side microcomputer must use the same clock for serial I/O operation. If an internal clock is used as operating clock, a transfer is started by a write signal to the transmit/receive buffer register.

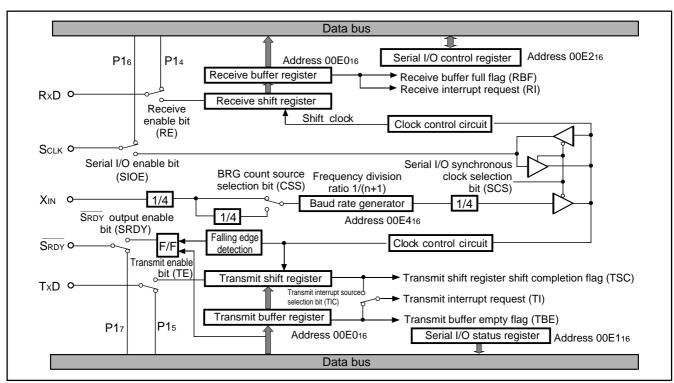


Fig. 28 Block diagram of clock synchronous serial I/O

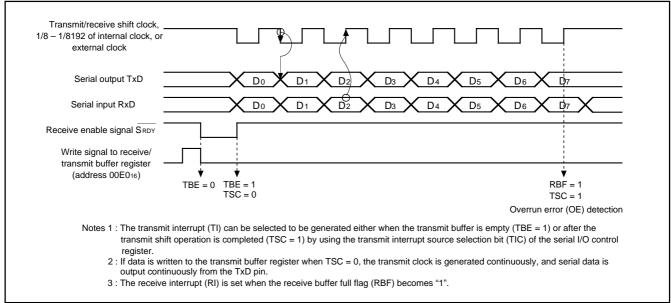
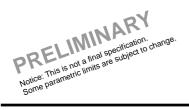


Fig. 29 Operation of clock synchronous serial I/O function







(2) Asynchronous Serial I/O (UART) Mode

The UART mode can be selected by clearing the serial I/O mode selection bit of the serial I/O control register to "0".

Eight serial data transfer formats can be selected, and the transfer formats to be used by a transmitter and a receiver must be identical

Each of the transmit and receive registers has a buffer register (the same address on memory). Since the shift register cannot be written to or read from directly, transmit data is written to the transmit buffer register and receive data is read from the receive buffer register. These buffer registers can also hold the next data to be transmitted and receive 2-byte receive data in succession.

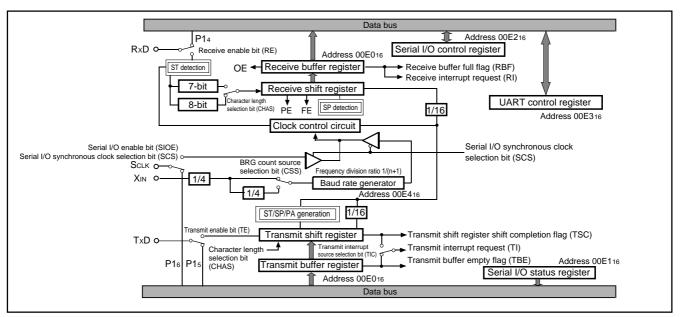


Fig. 30 Block diagram of UART serial I/O

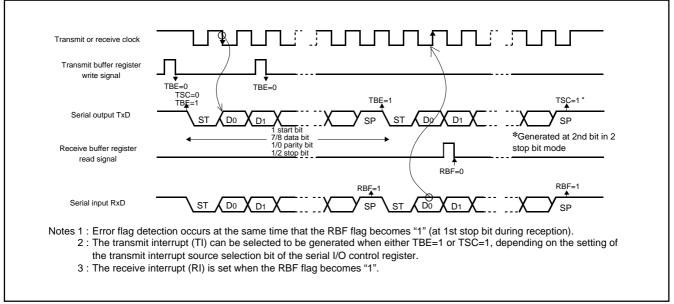


Fig. 31 Operation of UART serial I/O function





[Serial I/O Control Register] SIOCON

The serial I/O control register consists of 8 control bits for control of the serial I/O.

[UART Control Register] UARTCON

The UART control register is a 4-bit control register which is valid when UART is selected. This 4-bit control register sets a data format for serial data transfer.

[Serial I/O Status Register] SIOSTS

This is a 7-bit read-only register consisting of flags that indicate the serial I/O operating status and different error flags. The 3 bits of bit 4 to bit 6 are valid only in the UART mode.

The receive buffer full flag is cleared to "0" when the receive buffer register is read.

If there is an error, it is detected at the same time that data is transferred from the receive shift register to the receive buffer register, and the receive buffer full flag is set.

Writing to the serial I/O status register clears all the error flags (OE, PE, FE, SE).

All the bits of this register are initialized to "0" at reset.

However, if the transmit enable bit of the serial I/O control register is set to "1", bit 2 and bit 0 become "1".

[Transmit Buffer Register/Receive Buffer Register] TB/RG

The transmit buffer register and the receive buffer register are located at the same address. The transmit buffer register is a write-only type and the receive buffer register is a read-only type. If a character bit length is 7 bits, the MSB of the receive data stored in the receive buffer is "0".

[Baud Rate Generator] BRG

The baud rate generator determines a baud rate for serial transfer. The baud rate generator, being an 8-bit counter with a reload register, divides the frequency of the count source by 1/(n+1), where n is the value written to the baud rate generator.

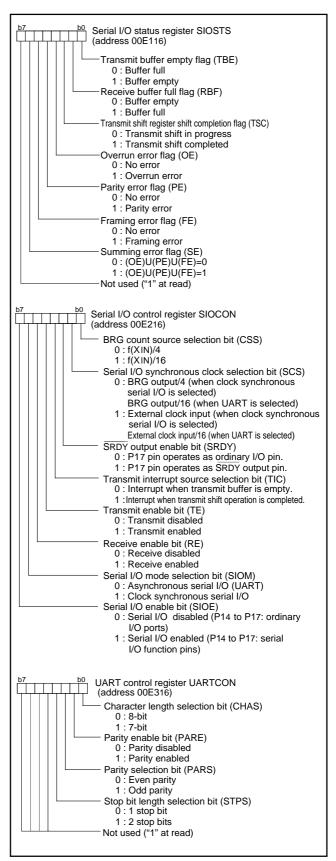


Fig. 32 Structure of serial I/O related registers (SIOSTS, UARTCON, SIOCON)





Bus Arbitration Interrupt

The 7480/7481 group is provided with a built-in bus arbitration interrupt as a function for bus conflict system communication. At such bus conflict system communication, as shown in Figure 33, if transmit data cannot be transmitted to the LAN data bus due to a transmit data collision, the data collision can be detected by the bus arbitration interrupt.

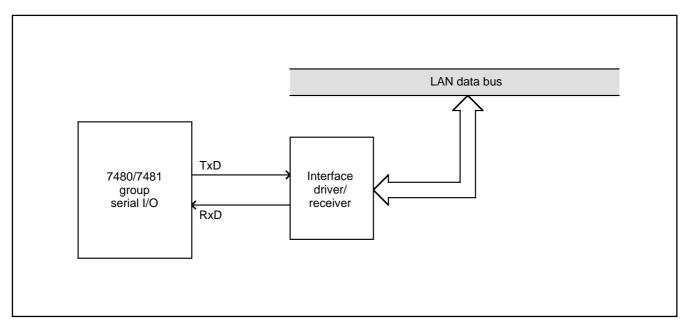


Fig. 33 Example of bus conflict system communication



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Bus Collision Detection

The 7480/7481 group can detect a bus collision by setting the bus collision detection enable bit to "1".

When transmission is started in the clock synchronous or asynchronous (UART) serial I/O mode, the transmit pin TxD is compared with the receive pin RxD in synchronization with a rising edge of transmit shift clock. If they do not coincide with each other, a bus arbitration interrupt request occurs (bus collision detection).

A transmit data collision is detected between LSB and MSB of transmit data in the clock synchronous serial I/O mode or between the start bit and stop bit of transmit data in the UART mode. Bus collision detection can be performed by both the internal clock and the external clock.

A block diagram is shown in Figure 34. A timing diagram is shown in Figure 35. A bus collision detection control register is shown in Figure 36.

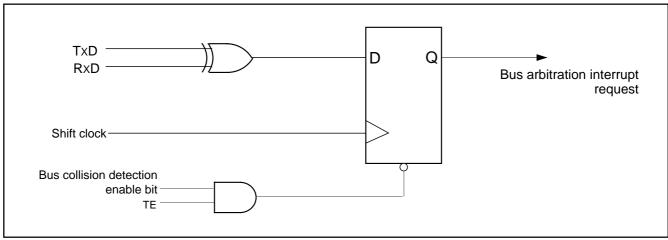


Fig. 34 Block diagram of bus arbitration interrupt circuit

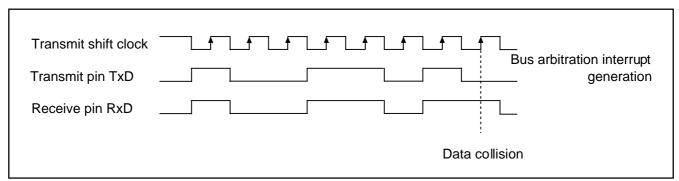


Fig. 35 Timing diagram of bus arbitration interrupt

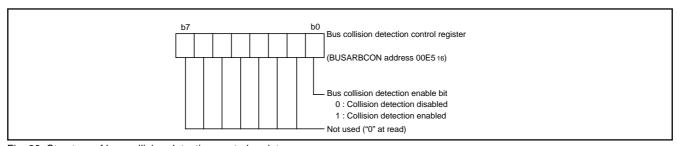


Fig. 36 Structure of bus collision detection control register





Application Example Priority Control at Simplified SAEJ1850

At simplified SAEJ1850 communication, when multiple units start to transmit data at the same time, priority control is exerted.

On the LAN data bus, the "H" level has priority over the "L" level. When an "H" level collides with an "L" level, the LAN data bus status goes to the "H" level.

For example, when unit A outputs "H" and unit B outputs "L" at the same time in Figure 37, the LAN data bus goes to "H". Accordingly, unit A takes priority of control and continues its transmission, and unit B stops its transmission immediately.

In this way, the 7480/7481 group exerts priority control for each bit and finally allows only the highest-priority unit to transmit data.

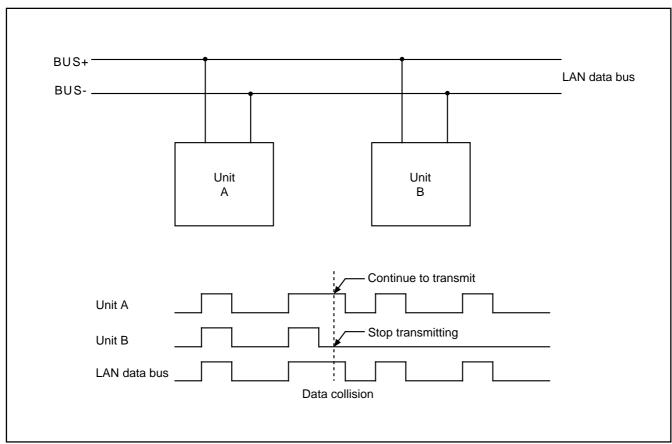


Fig. 37 Priority control at simplified SAEJ1850



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A-D Converter

For A-D conversion, the 8-bit successive comparison method is used. Figure 38 shows a block diagram of A-D conversion. Conversion is automatically performed once started by the program. There are 8 analog input pins that are in common with P27 to P20

of port P2 (4 pins of P23 to P20 in the 7480 group).

Pin inputs to be A-D converted are selected by bit 2 to bit 0 of the A-D control register (address 00D916). Bit 3 of the A-D control register is an A-D conversion completion bit. This bit is "0" during A-D conversion and "1" after completion of it. Accordingly, it is possible by checking this bit to know whether A-D conversion is completed or not. Figure 39 shows the relationship between the contents of the A-D control register and input pins to be selected.

The A-D conversion register (address 00DA₁₆) stores conversion results, so it is possible to know them by reading the contents of this register.

Next, the procedure for executing A-D conversion will be explained below. First, set values in bit 2 to bit 0 of the A-D control register and select pins to be A-D converted.

Next, clear the A-D conversion completion bit to "0". With this write operation, A-D conversion is started. The A-D conversion is completed after the lapse of 50 machine cycles (12.5 μ s at f(XIN)= 8 MHz), and the A-D conversion completion bit is set to "1". The A-D conversion interrupt request bit is also set to "1". Conversion results are stored in the A-D conversion register.

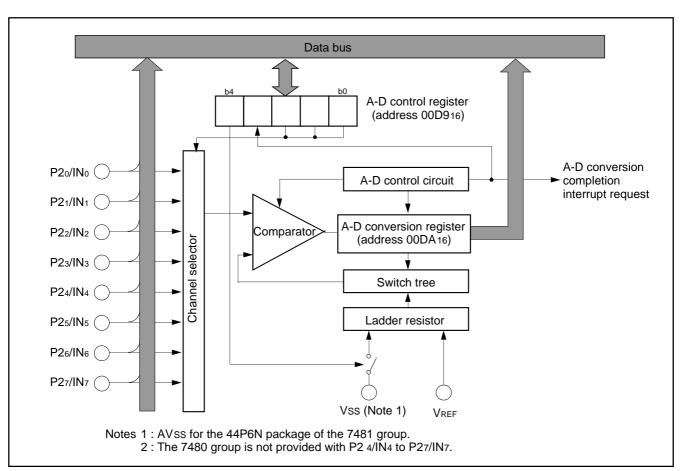


Fig. 38 Block diagram of A-D converter circuit



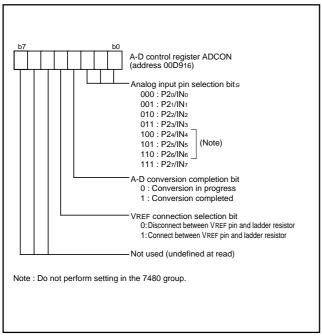


Fig. 39 Structure of A-D control register



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Watchdog Timer

The watchdog timer gives a means for returning to a reset status when the program fails to run on its normal loop due to a runaway. The watchdog timer consists of a 7-bit watchdog timer L and an 8-bit watchdog timer H.

• Initial Value of Watchdog Timer

By a reset or writing to the watchdog timer H, the watchdog timer H is set to "FF16" and the watchdog timer L is set to "7F16". Any instruction that permits generating a write signal can be used; for example, STA, LDM, CLB, etc. Write data has no significance, so the above values are set regardless of that data.

Operation of Watchdog Timer

The watchdog timer stops at reset, and writing a value in the watchdog timer H causes it to start to count down. When bit 7 of the watchdog timer H becomes "0", an internal reset occurs.

The reset status is released as soon as the release reset time is

up. After that, the 7480/7481 group runs the program from the reset vector address. It is programmed that the watchdog timer H can be set before bit 7 of the watchdog timer H is cleared to "0". If the watchdog timer H is never written, the watchdog timer does not function. When the STP instruction is executed, the clock stops and the watchdog timer also stops. The count is restarted as soon as the stop mode is released. (Note) On the other hand, the watchdog timer does not stop after execution of the WIT instruction.

The timing from writing to the watchdog timer H to clearing bit 7 of the watchdog timer H to "0" is shown below. (f(XIN)=8 MHz)

- When bit 3 of the CPU mode register is "0" 16.384 ms
- When bit 3 of the CPU mode register is "1" 32.768 ms

Note: Since the watchdog timer still counts for the stop release waiting time (about 2048 cycles of XIN), bit 7 of the watchdog timer H should not be cleared to "0" in this period.

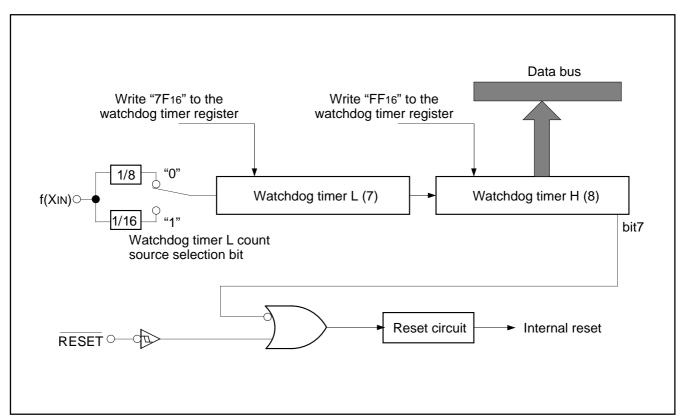
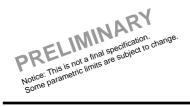


Fig. 40 Block diagram of watchdog timer



STP/WIT Instruction Control

The STP instruction and the WIT instruction can be enabled or disabled selectively by using the STP instruction operation control register. To cope with a program runaway after reset, the STP instruction and the WIT instruction are disabled in the initial status.

The STP and WIT instructions can be set as enable/disable only by writing to the STP instruction operation control register twice successively so as not to stop the oscillation clock even if a write data error is caused by program runaway. Figure 41 shows a structure of the STP instruction operation control register.

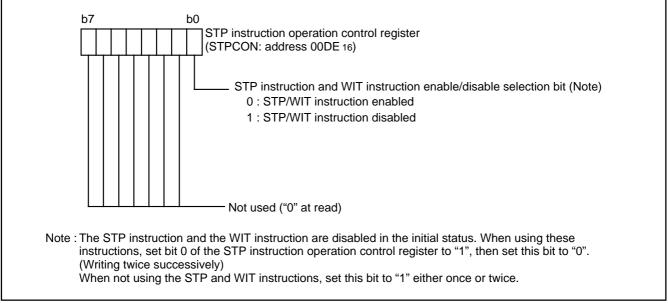


Fig. 41 Structure of STP instruction operation control register

Explanation of STP Instruction Operation Control Register

The STP instruction operation control register will be enabled by writing data to the same address twice successively. If data is not written in continuous form, the written data is not valid but the previous value is held.

If an interrupt is received while the same data is written twice, there is a possibility that the write instruction in the interrupt routine may be executed. For this reason, rewriting is required after interrupt disable. Figure 42 shows a reference example of data rewriting.

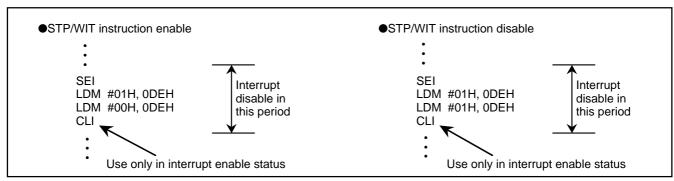


Fig. 42 Reference example of data rewriting





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

Recovery From Power-down Status By Key Input Interrupt (Key-on wake-up)

"Key-on wake-up" is one way of recovery from a power-down status by using the STP or WIT instruction.

If an "L" level voltage is input to any pin of port P0 when bit 5 of the edge polarity selection register is "1", an interrupt occurs, and a recovery can be made to the normal operating state. If a key matrix of active "L" with port P0 as an input port is constructed, a recovery can be made to the normal operating status by pressing a key.

The key input interrupt is in common with the INT1 interrupt. When bit 5 of the edge polarity selection register is set to "1", the key input interrupt function is selected. If this bit is set to "1" except in the power-down status, both INT1 and key-on wake-up are invalidated.

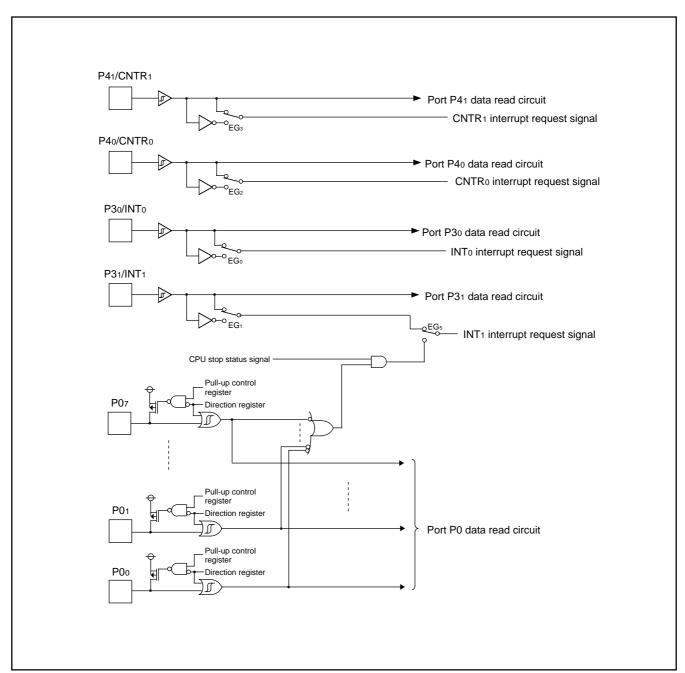


Fig. 43 Block diagram of interrupt input/key-on wake-up circuit



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Clock Generating Circuit

The 7480/7481 group is provided with a built-in oscillation circuit. An oscillation circuit can be formed by connecting a resonator between XIN and XOUT. Use the manufacturer's recommended values for constants such as capacitance, which will differ depending on each resonator. The 7480/7481 group has a built-in feedback resistor between the XIN and XOUT pins, so an external resistor can be omitted.

Frequency Control

(1) High-speed Mode

The frequency applied to the clock input pin XIN divided by 2 is used as the internal clock ϕ . This mode is set after reset release. (2) Medium-speed Mode

The frequency applied to the clock input pin XIN divided by 8 is used as the internal clock ϕ .

Oscillation Frequency

(1) Stop Mode

If the STP instruction is executed, the internal clock ϕ stops at an "H" level, and the oscillator stops. At this time, timer 1 is set to "FF16," and f(XIN)/8 is forcibly connected to the count source of timer 1. Accordingly, set the timer 1 interrupt enable bit to the disable status ("0") before execution of the STP instruction.

When a reset or an external interrupt is accepted, oscillation is restarted, but the internal clock ϕ is supplied to the CPU after timer 1 underflows. This is because when an external resonator is used, some time is required until a start of oscillation.

(2) Wait Mode

If the WIT instruction is executed, the internal clock ϕ stops at an "H" level. But, the oscillator does not stop. When a reset or interrupt is accepted, the stop status is released. The microcomputer can execute any instruction immediately, because the oscillator does not stop.

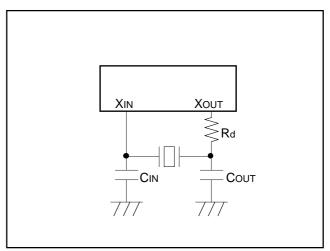


Fig. 44 External circuit of ceramic resonator

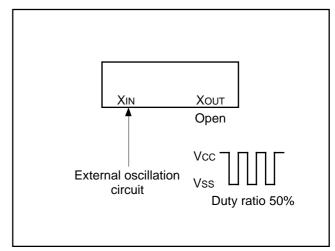


Fig. 45 External clock input circuit



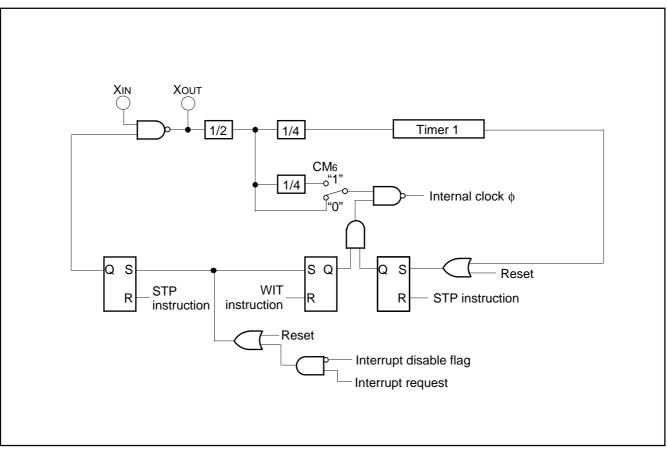


Fig. 46 Block diagram of clock generating circuit



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

Reset Circuit

The microcomputer is put into a reset status by holding the $\overline{\text{RESET}}$ pin at the "L" level for $2\mu \text{s}$ or more when the power source voltage is 2.7 to 5.5 V and XIN is in stable oscillation.

After that, this reset status is released by returning the RESET pin to the "H" level. The program starts from the address having the contents of address FFFF16 as high-order address and the contents of address FFFE16 as low-order address.

Note that the reset input voltage should be $0.32~\rm V$ or less when the power source voltage passes $2.7~\rm V$.

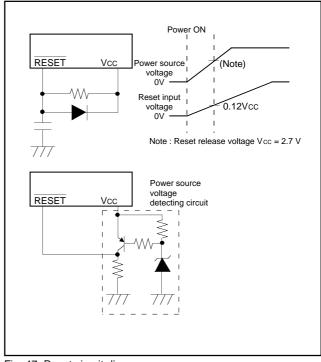


Fig. 47 Reset circuit diagram

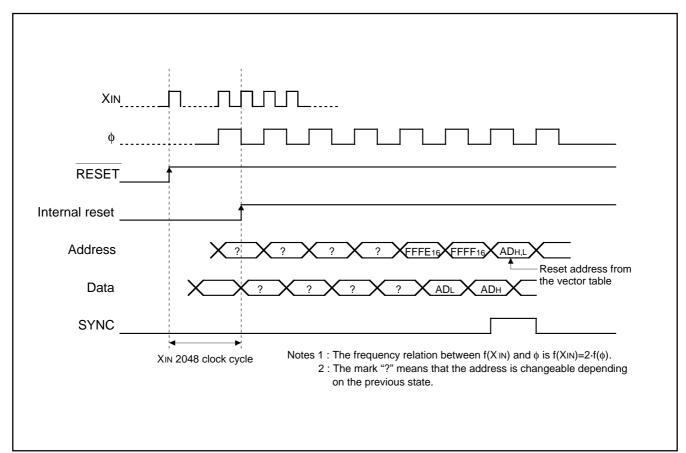


Fig. 48 Reset sequence





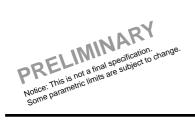
SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

(1)	Port P0 direction register (P0D)	Address (C1 ₁₆) · · ·	0016 b0	
(2)	Port P1 direction register (P1D)	(C3 ₁₆)	0016	
(3)	Port P4 direction register (P4D)	`.		
	Port P5 direction register (P5D)	(CP46) · · · [00000	
(4)	5 (,	(CB ₁₆) · · · [0016	
(5)	Port P0 pull-up control register (P0PCON) Port P1 pull-up control register (P1PCON)	(D1 40)		
(6)	, ,	(D1 ₁₆) · · · [0016	
(7)	Port P4P5 input control register (P4P5CON)	(D216) ••• [
(8)	Edge polarity selection register (EG)	(D4 ₁₆)	0 0 0 0 0	
(9)	A-D control register (ADCON)	(D5-1)	0 1 0 0 0	
(10)	STP instruction operation control register (STPCON)	`	0 0 0 0 0 0 0 1	
(11)	Serial I/O status register (SIOSTS)	` /	0046	
(12)	Serial I/O control register (SIOCON)	(E2 ₁₆) ••• [0016	
(13)	UART control register (UARTCON)	` ′ [1 1 1 1 0 0 0 0	
(14)	Bus collision detection control register (BUSARBCON)	(E5 ₁₆)	0016	
(15)	Watchdog timer H (WDTH)	(EF ₁₆) ••• [FF16	
(16)	Timer X low-order (TXL)	(F0 16) ••• [FF16	
(17)	Timer X high-order (TXH)	(F1 16) ••• [FF16	
(18)	Timer Y low-order (TYL)	(F2 16) ••• [FF16	
(19)	Timer Y high-order (TYH)	(F3 16) ••• [FF16	
(20)	Timer 1 (T1)	(F4 ₁₆) ••• [FF16	
(21)	Timer X mode register (TXM)	(F6 16) • • •	0016	
(22)	Timer Y mode register (TYM)	(F7 16) • • • [0016	
(23)	Timer XY control register (TXYCON)	(F8 ₁₆) • • •	0 0 0 0 0 0 1 1	
(24)	Timer 1 mode register (T1M)	(F9 ₁₆) • • •	0016	
(25)	Timer 2 mode register (T2M)	(FA ₁₆) •••	0016	
(26)	CPU mode register (CPUM)	(FB 16) •••	0 0000	
(27)	Interrupt request register 1 (IREQ1)	(FC 16) •••	0016	
(28)	Interrupt request register 2 (IREQ2)	(FD 16) •••	0000	
(29)	Interrupt control register 1 (ICON1)	(FE 16) •••	0016	
(30)	Interrupt control register 2 (ICON2)	(FF 16) •••	0000	
(31)	Program counter (PC H)	[(Contents of address FFFF16	
	(PCL)		Contents of address FFFE16	
(32)	Processor status register (PS)			
	: At reset release, the read value	e is undefine	d.	
Note : Son	ne kinds of microcomputers do not use some of	these bits. R	Refer to the structure of eac	ch register.

Fig. 49 Internal state of microcomputer at reset







BUILT-IN PROGRAMMABLE ROM VERSIONS M37480E8-XXXSP/FP, M37480E8T-XXXSP/FP, M37481E8-XXXSP/FP, M37481E8T-XXXSP/FP, M37481E8SS PIN DESCRIPTION

Table 5. Pin description

Pin	Mode	Name	Input/ output	Function
Vcc, Vss AVss (Note 1)	Single-chip/ EPROM	Power source		Apply a voltage of 2.7 to 5.5 V to Vcc and 0 V to Vss and AVss.
VREF	Single-chip	Reference power input	Input	Reference voltage input pin for A-D converter.
	EPROM	Mode input	Input	Used as CE input pin.
	Single-chip	Reset input	Input	Reset input pin.
RESET	EPROM	Reset input	Input	Connect to Vss.
XIN	Single-chip/ EPROM	Clock input	Input	These are I/O pins of internal clock generating circuit for the main clock. To control generating frequency, an external ceramic resonator is connected between XIN and XOUT pins. If an external clock is
Хоит	Single-chip/ EPROM	Clock output	Output	used, the clock oscillation source should be connected to the XIN pin, and the XOUT pin should be left open. Feedback resistor is connected between XIN and XOUT.
P00 – P07	Single-chip	I/O port P0	I/O	8-bit I/O port. The output structure is CMOS output. When this port is selected for input, a pull-up transistor can be connected in units of 1 bit, and a key-on wake-up function is provided.
	EPROM	Data I/O Do - D7	I/O	Data 8-bit (Do to D7) I/O pins
P10 – P17	Single-chip	I/O port P1	I/O	8-bit I/O port. The output structure is CMOS output. When this port is selected for input, a pull-up transistor can be connected in units of 4 bits. P12 and P13 are in common with timer output pins To and T1. P14, P15, P16 and P17 are in common with serial I/O pins RxD, TxD, Sclk and SRDY.
	EPROM	Address input A4 – A10	Input	P11 to P17 are address (A4 to A10) input pins. Leave P10 open.
P20 – P27	Single-chip	Input port P2	Input	8-bit input port. This port is in common with analog input pins INo to IN7 (INo to IN3 for the 7480 group).
(Note 2)	EPROM	Address input A0 – A3	Input	P20 to P23 are address (A0 to A3) input pins. Leave P24 to P27 open.
	Single-chip	Input port P3	Input	4-bit input port. P30 and P31 are in common with external interrupt input pins INT0 and INT1.
P30 – P33	EPROM	Address input A11, A12, mode input, VPP input	Input	P30 and P31 are address (A11, A12) input pins. P32 is used for $\overline{\text{OE}}$ input. P33 is VPP input. Apply VPP in the program and program verify modes.
P40 – P43 (Note 3)	Single-chip	I/O port P4	I/O	4-bit I/O port. The output structure is N-channel open drain output, having built-in clamp diode. P40 and P41 are in common with timer input pins CNTR0 and CNTR1.
(14010-0)	EPROM	Address input A13, A14	Input	P40 and P41 are address (A13, A14) input pins. Leave P42 and P43 open.
P50 – P53 (Note 4)	Single-chip	I/O port P5	I/O	4-bit I/O port. The output structure is N-channel open drain output, having a built-in clamp diode.
(1.1010 -1)	EPROM	Input port P5	Input	Leave these pins open.

Notes 1: This is a dedicated pin for the 44P6N-A package in the 7481 group.

- 2: Only 4 bits of P20 to P23 (IN0 to IN3) for the 7480 group.
- 3: Only 2 bits of P40 and P41 for the 7480 group.
- 4: This is a dedicated pin for the 7481 group.





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

EPROM MODE

The built-in programmable ROM has the EPROM mode in addition to its normal operation modes. When the RESET level becomes "L", the chip automatically enters the EPROM mode. Table 6 shows a list of correspondence between pins and Figure 50 to Figure 52 show pin connection diagrams. In this status, each of ports P0, P11 to P17, P20 to P23, P3, P40, P41 and VREF are used for the PROM (equivalent to M5M27C256K). In this mode, the built-in PROM can be written to or read from using these pins in the same way as with the M5M27C256K. The clock should be connected to XIN and XOUT pins.

Table 6. Correspondence between pins in EPROM mode

	M37480E8, M37481E8	M5M27C256K
Vcc	Vcc	Vcc
VPP	P33	VPP
Vss	Vss	Vss
Address input	Ports P11 – P17, P20 – P23, P30, P31, P40, P41	A0 – A14
Data I/O	Port P0	D0 – D7
CE	VREF	CE
ŌĒ	P32	ŌĒ

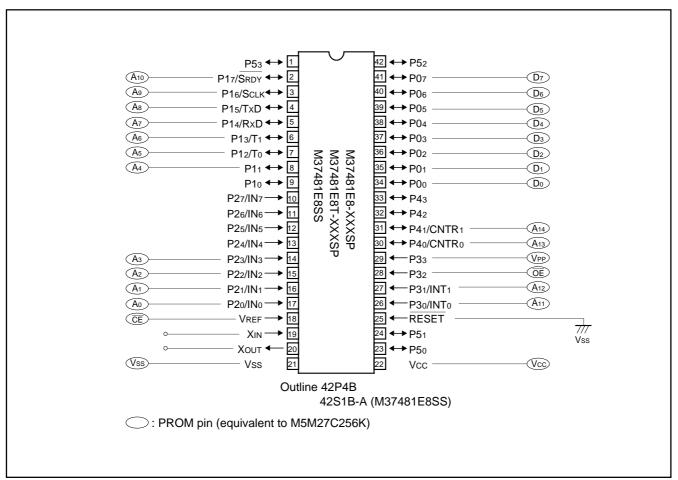


Fig. 50 Pin connection in EPROM mode (1)



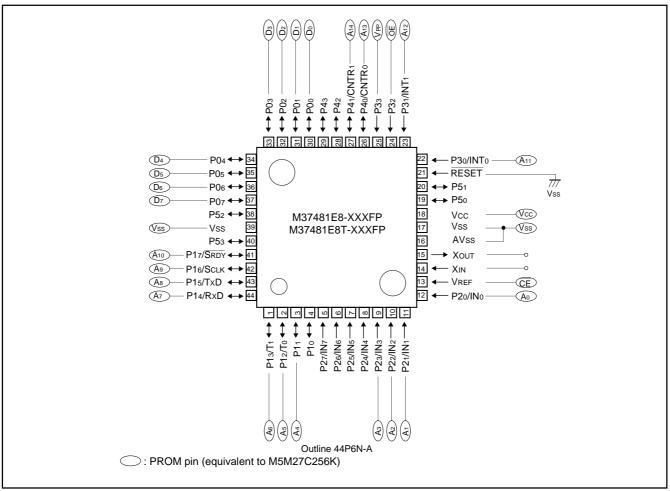


Fig. 51 Pin connection in EPROM mode (2)

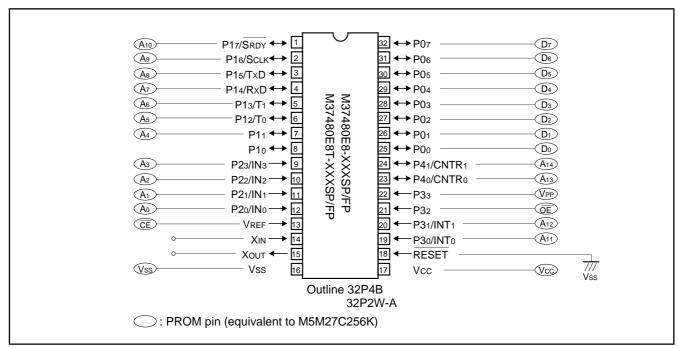


Fig. 52 Pin connection in EPROM mode (3)





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

FUNCTIONAL DESCRIPTION OF PROM VERSION Reading

To read the PROM, set the \overline{CE} and \overline{OE} pins to "L" level, and set the address signal (A0 to A14). The stored contents will appear to data I/O pins (D0 to D7). When the \overline{CE} and \overline{OE} pins are set to "H" level, the data I/O pins will be put into a floating status.

Writing

To write to the PROM, apply "H" to the \overline{OE} pin and VPP to the VPP pin to set the program mode. Select addresses to be written to with address input pins (A0 to A14) and give write data to the data input pins (D0 to D7) in 8-bit parallel form. In this status, when the \overline{CE} pin becomes "L", writing will be started.

Notes on Writing

When using a PROM programmer, specify the address range to address 400016 to address 7FFF16.

When data is written between address 000016 and address 7FFF16, fill addresses 000016 to 3FFF16 with "FF16".

Erasing

Data can be erased only on the ceramic package with window M37481E8SS. To erase data on this chip, use an ultraviolet light source with a 2537 Angstrom wave length. The minimum radiation power required for erasing is 15W·s/cm².

NOTES ON HANDLING

- (1) Sunlight and fluorescent light contain wavelengths capable of erasing data. For use in the read mode, be sure to cover the transparent window with a seal. (Ceramic package type)
- (2) We can supply the seal with which the transparent window is covered. Be careful not to allow the seal to contact the microcomputer lead pins. (Ceramic package type)
- (3) Before erasing, clean the transparent glass. If the glass is smeared with greasy hands or paste, ultraviolet light transmission will be prevented, having a negative effect on erasing characteristics. (Ceramic package type)
- (4) Since a high voltage is used for writing data, care should be taken not to apply an overvoltage when turning on the power source.
- (5) For the programmable microcomputers (one-time programmable version, version shipped in blank), Mitsubishi does not perform PROM write testing and screening in the assembly process and subsequent processes. To improve reliability after writing, perform writing and testing according to the following operation flow before use.

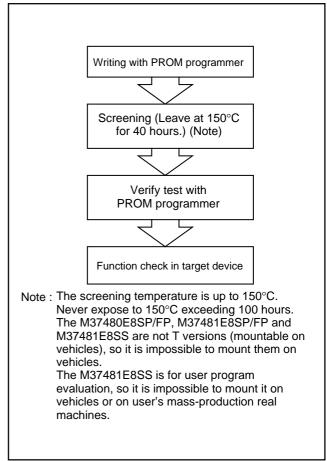


Fig. 53 Writing and testing for one-time programmable version







I/O SIGNALS IN EACH MODE

Table 7. I/O signals in each mode

Pin	CE	ŌĒ	VPP	Vcc	Data I/O
Read-out	VIL	VIL	Vcc	Vcc	Output
Output disable	VIL	ViH	Vcc	Vcc	Floating
Programming	VIL	ViH	VPP	Vcc	Input
Programming verify	ViH	VIL	VPP	Vcc	Output
Program disable	ViH	ViH	VPP	Vcc	Floating

Note: VIL and VIH denote an "L" input voltage and an "H" input voltage, respectively.

MITSUBISHI MICROCOMPUTERS

7480/7481 GROUP



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

ADDRESSING MODES

The 7480/7481 group has strong accessability, because it has 17 kinds of addressing modes. For details, refer to the 740 family addressing modes.

MACHINE-LANGUAGE INSTRUCTIONS

The 7480/7481 group has 71 machine-language instructions. For details, refer to the 740 family machine-language instruction list.

NOTES ON PROGRAMMING

(1) The frequency division ratio of the timer is 1/(n+1).

n: Timer setting value

However, n = 0 - 255 (for timer 1, timer 2)

n = 0 - 65535 (timer X, timer Y)

(2) The contents of the interrupt request bits can be changed by software, but the values will not change immediately after being overwritten.

After changing the value of the interrupt request bits, execute at least one instruction before executing a the BBC or BBS instruction.

- (3) To calculate in decimal notation, set the decimal mode flag (D) to "1". After executing the ADC or SBC instruction, execute another instruction before executing the SEC, CLC, or CLD instruction.
- (4) A NOP instruction should be executed after every PLP instruc-
- (5) Do not execute the STP instruction during A-D conversion.
- (6) Multiplication and Division Instructions

The index X mode (T) and the decimal mode (D) flags do not affect the MUL and DIV instructions.

The execution of these instructions does not change the contents of the processor status register.

DATA REQUIRED FOR MASK ORDERING

Please submit the following data when placing mask orders.

- (1) Mask ROM confirmation form
- (2) Mark specification form
- (3) ROM data EPROM 3 sets

DATA REQUIRED FOR ROM WRITING ORDERING

Please submit the following data when placing ROM writing orders.

- (1) ROM writing confirmation form
- (2) Mark specification form
- (3) ROM data EPROM 3 sets





M37480M4/M8/E8-XXXSP/FP, M37480M2T/M4T/M8T/E8T-XXXSP/FP ABSOLUTE MAXIMUM RATINGS (7480 Group)

Table 8. Absolute maximum ratings

Symbol	Parameter	Condition	Rated value	Unit
Vcc	Power source voltage	All voltages are measured on the basis	-0.3 to 7	V
VI	Input voltage	of the Vss pin.	-0.3 to Vcc + 0.3	V
Vo	Output voltage	Output transistors are cut off.	-0.3 to Vcc + 0.3	V
Pd	Power dissipation	Ta = 25 °C	1000 (Note 1)	mW
Topr	Operating temperature range		-20 to 85 (Note 2)	°C
Tstg	Storage temperature		-40 to 150 (Note 3)	°C

Notes 1:500 mW for 32P2W-A package type.

2: -40 to 85 °C for extended operating temperature range version.

3 : –65 to 150 $^{\circ}\text{C}$ for extended operating temperature range version.

RECOMMENDED OPERATING CONDITIONS (7480 Group)

(Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to $85^{\circ}C$ (Note 1) unless otherwise specified)

Table 9. Recommended operating conditions

Symbol	Parameter		Sta	andard val	ues	Unit
Symbol	Farameter		Min.	Тур.	Max.	Offic
Voc	Dower course velters	f(XIN) = (2.2VCC - 2) MHz	2.7	3	4.5	V
Vcc	Power source voltage	f(XIN) = 8 MHz	4.5	5	5.5	V
Vss	Power source voltage			0		V
VIH	"H" input voltage P00 - P07, P10 - P17		0.8 Vcc		Vcc	V
VIH	"H" input voltage P20 - P23		0.7 Vcc		Vcc	V
Mus	"I I" input voltage D2c D2c	Vcc = 4.5 to 5.5 V	0.8 Vcc		Vcc	V
VIH	"H" input voltage P30 – P33	Vcc = 2.7 to 4.5 V	0.9 Vcc		Vcc	V
VIH	"I I" input voltage D4s D4s (Note 4)	Vcc = 4.5 to 5.5 V	0.8 Vcc		Vcc	V
VIH	"H" input voltage P40 – P41 (Note 4)	Vcc = 2.7 to 4.5 V	0.9 Vcc		Vcc	V
VIH	"H" input voltage XIN, RESET		0.8 Vcc		Vcc	V
VIL	"L" input voltage P00 - P07, P10 - P17		0		0.2 Vcc	V
VIL	"L" input voltage P20 – P23		0		0.25 Vcc	V
VIL	W. and the second	Vcc = 4.5 to 5.5 V	0		0.4 Vcc	V
VIL	"L" input voltage P30 – P33	Vcc = 2.7 to 4.5 V	0		0.3 Vcc	V
\/	W. P. Sanda and D. C. D. A.	Vcc = 4.5 to 5.5 V	0		0.4 Vcc	V
VIL	"L" input voltage P40 – P41	Vcc = 2.7 to 4.5 V	0		0.3 Vcc	V
VIL	"L" input voltage XIN		0		0.16 Vcc	V
VIL	"L" input voltage RESET		0		0.12 Vcc	V
lı	Input current P40 – P41 (Note 4) VI > VCC				1	mA
IOH(sum)	"H" sum output current P00 - P07				- 30	mA
IOH(sum)	"H" sum output current P10 – P17				- 30	mA
IOL(sum)	"L" sum output current P00 - P07, P40 - P41	1			60	mA
IOL(sum)	"L" sum output current P10 – P17	"L" sum output current P10 – P17			60	mA
IOH(peak)	"H" peak output current P00 – P07, P10 – P1	"H" peak output current P00 – P07, P10 – P17			- 10	mA
IOL(peak)	"L" peak output current P00 - P07, P10 - P1	"L" peak output current P00 – P07, P10 – P17, P40 – P41			20	mA
IOH(avg)	"H" average output current P00 - P07, P10 -	- P17 (Note 2)			- 5	mA
IOL(avg)	"L" average output current P00 – P07, P10 –	P17, P40 – P41 (Note 2)			10	mA





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

Table 9. Recommended operating conditions (cont.)

Cumbal		Parameter			Standard values		
Symbol		Parameter		Min.	Тур.	Max.	Unit
f(CNTD)	(CNTR) Timer input frequency CNTR ₀ (P4 ₀), CNTR ₁ (P4 ₁) (Note 3)		f(XIN) = 4 MHz			1	MHz
I(CNTK)			f(XIN) = 8 MHz			2	IVITIZ
		Clock synchronous serial I/O mode	f(XIN) = 4 MHz			250	kHz
f(\$0.14)	Serial I/O clock input		f(XIN) = 8 MHz			500	KHZ
f(SCLK)	frequency SCLK (P16) (Note 3)		f(XIN) = 4 MHz			1	MHz
	(Note 3) UART mode		f(XIN) = 8 MHz			2	IVITIZ
f(XIN)	Clack input ascillation from	guanay (Nata 3)	Vcc = 2.7 to 4.5 V			2.2Vcc-2	MHz
	Clock input oscillation frequency (Note 3)		Vcc = 4.5 to 5.5 V			8	IVII□Z

Notes 1: -40 to 85 °C for extended operating temperature range version.

- 2: The average output currents IOH(avg) and IOL(avg) are the average values during 100 ms.
- 3: The clock input oscillation frequency is at 50 % duty ratio.
- 4: When applying a voltage through a resistor as shown in the figure 54, VI > VCC may be accepted if the current is 1 mA or less.

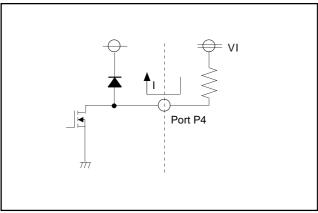


Fig. 54 Note on use of port P4

Notes on Clamp Diode (7480 Group)

(1) Total input current

The current of port P4 through the clamp diode can be drawn up to 1.0 mA per port. When a current that cannot be consumed by microcomputer is sent to the clamp diode, this may raise the power source pin voltage of the microcomputer.

The system power circuit must be designed so that the power source voltage of the microcomputer may be stabilized within standard values.

(2) Maximum input voltage

If the input voltage of a signal connected to port P4 is beyond Vcc + 0.3 V, the input waveform should have a delay exceeding 2 μ s/V from the moment that this waveform goes over the voltage.

For using a CR circuit for delay, calculate a proper delay value by the following expression:

$$\frac{dt}{dv} = \frac{t}{0.6 \text{ X Vin}} \ge 2 \text{ X } 10^{-6} \text{ (s/V)}$$

where VIN = Maximum input voltage amplitude margin and $t = C \times R$.

The clamp diode of the 7480/7481 group is designed for a level shift of DC signal unlike ordinary switching diodes. Do not apply sudden stress, such as rush current, directly to the diode.

Notes on Countermeasures for Noise and Latch-up (7480 Group)

- (1) Connect a bypass capacitor (0.1µF) across the Vcc pin and the Vss pin with the shortest possible wiring, using a relatively thick wire.
- (2) Connect a bypass capacitor (0.01 μ F) across the VREF pin and the Vss pin with the shortest possible wiring, using a relatively thick wire
- (3) In the oscillation circuit, connect across the XIN and XOUT pins with the shortest possible wiring. Connect the GND and Vss pins of the oscillation circuit with the shortest possible wiring, using a relatively thick wire.
- (4) In the case of the P33/VPP pin of the built-in programmable ROM version, connect an approximately 5 k Ω resistor to the P33/VPP pin the shortest possible in series.





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

M37480M4/M8/E8-XXXSP/FP, M37480M2T/M4T/M8T/E8T-XXXSP/FP ELECTRICAL CHARACTERISTICS (7480 Group)

(Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C (Note 1) unless otherwise specified)

Table 10. Electrical characteristics

Symbol	Parameter	Toot conditions		St	andard valu	es	Unit
Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
1/2	"H" output voltage	VCC = 5 V, IOH = -5 mA		3			.,
Voн	P00 – P07, P10 – P17	VCC = 3 V, IOH = −1.5 mA		2			V
1/	"L" output voltage	VCC = 5 V, IOL = 10 mA				2	.,
Vol	P00 – P07, P10 – P17, P40 – P41	VCC = 3 V, IOL = 3 mA				1	V
\/_ \/_	Hysteresis P00 – P07,	Vcc = 5 V			0.5		.,
VT + - VT-	P30 - P33, P40 - P41 (Note 2)	Vcc = 3 V			0.3		V
\/- \/-	Library and Display Display Display	When used as SCLK, RxD	Vcc = 5 V		0.5		.,
VT + - VT-	Hysteresis P16/SCLK, P14/RXD	input	Vcc = 3 V		0.3		V
\\		Vcc = 5 V	'		0.5		,,
VT + - VT-	Hysteresis RESET	Vcc = 3 V			0.3		V
	"H" input current	VI = VCC without pull-up	Vcc = 5 V			5	
IIН	P00 – P07, P10 – P17	transistor VCC = 3 V				3	- μΑ
1	"H" input current	VI = VCC = 5 V	'			5	
lін	P30 – P33, P40 – P41	VI = VCC = 3 V				3	μA
1	#1# '1 PO PO-	VI = VCC when analog	Vcc = 5 V			5	
lін	"H" input current P20 – P23	input is not selected	Vcc = 3 V			3	μA
I.e.	#IN:	VI = VCC	Vcc = 5 V			5	
lін	"H" input current RESET, XIN	(XIN at stop)	Vcc = 3 V			3	μA
		VI = 0 V without pull-up	Vcc = 5 V			- 5	
L	"L" input current	transistor	Vcc = 3 V			-3	μA
liL	P00 – P07, P10 – P17	VI = 0 V with pull-up	Vcc = 5 V	-0.25	-0.5	-1.0	^
		transistor (Note 3)	Vcc = 3 V	-0.08	-0.18	-0.35	- mA
1	"L" input current	16. 014	Vcc = 5 V			-5	
lıL	P30 – P33, P40 – P41	P40 – P41				-3	μA
I.i.	"I " :	VI = 0 V when analog input	Vcc = 5 V			-5	
lıL	"L" input current P20 – P23	is not selected	Vcc = 3 V			-3	μA
I.i.	"I" in and a second DECET Vivi	VI = 0 V	Vcc = 5 V			- 5	
liL	"L" input current RESET, XIN	(XIN at stop)	Vcc = 3 V			-3	μA

Notes 1: -40 to 85 °C for extended operating temperature range version.

When VCC = 5 V: 5 k Ω (min.), 10 k Ω (typ.), 20 k Ω (max.).

When VCC = 3 V: 8.6 k Ω (min.), 16.7 k Ω (typ.), 37.5 k Ω (max.).



^{2:} At using P0 for key-on wake-up function.

^{3 :} Can be indicated in resistance value as shown below:





M37480M4/M8/E8-XXXSP/FP, M37480M2T/M4T/M8T/E8T-XXXSP/FP

Table 10. Electrical characteristics (cont.)

Symbol	Parameter		Test condition	ons	St	andard valu	es	Uni
	raidinotor				Min.	Тур.	Max.	0
VRAM	RAM retention voltage	At	clock stop mode		2			V
			In high-speed mode, f(XIN) = 4 MHz,	A-D conversion not executed		3.5	7	m/
			VCC = 5 V	A-D conversion in progress		4	8	m/
			In high-speed mode,	A-D conversion not executed		1.8	3.6	m/
			f(XIN) = 4 MHz, Vcc = 3 V	A-D conversion in progress		2	4	m/
		ge	In high-speed mode,	A-D conversion not executed		7	14	m/
		ng mo	f(XIN) = 8 MHz, $VCC = 5 V$	A-D conversion in progress		7.5	15	m/
	operating mode	In medium-speed	A-D conversion not executed		1.75	3.5	m/	
	u u	mode, f(XIN) = 4 MHz, Vcc = 5 V	A-D conversion in progress		2	4	m/	
			In medium-speed mode, f(XIN) = 4 MHz, VCC = 3 V	A-D conversion not executed		0.9	1.8	m/
la a		ower source current		A-D conversion in progress		1	2	m/
Icc	Power source current			In medium-speed mode, f(XIN) = 8 MHz,	A-D conversion not executed		3.5	7
			Vcc = 5 V	A-D conversion in progress		3.75	7.5	m/
			In high-speed mode,	Vcc = 5 V		1	2	
			f(XIN) = 4 MHz	Vcc = 3 V		0.5	1	m/
		wait mode	In high-speed mode, f(XIN) = 8 MHz	Vcc = 5 V		2	4	
		In wait	In medium-speed	Vcc = 5 V		0.9	1.8	
		mode, f(XIN) = 4 MHz	Vcc = 3 V		0.45	0.9	m/	
			In medium-speed mode, f(XIN) = 8 MHz	Vcc = 5 V		1.8	3.6	
		stop mode	f(XIN) = 0	Ta = 25 °C		0.1	1	μA
		In stop	Vcc = 5 V	Ta = 85 °C		1	10	μA





M37480M4/M8/E8-XXXSP/FP, M37480M2T/M4T/M8T/E8T-XXXSP/FP A-D CONVERSION CHARACTERISTICS (7480 Group)

(VCC = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C (Note) unless otherwise specified)

Table 11. A-D conversion characteristics

Cumbal	Doromotor	Test conditions	St	Standard values			
Symbol	Parameter	lest conditions	Min.	Тур.	Max.	Unit	
	Resolution				8	bits	
	Absolute accuracy (except quantization error)	VCC = VREF = 5.0 V			±2	LSB	
TCONV	Conversion time	VCC = 2.7 to 5.5 V, f(XIN) = 4 MHz			25		
ICONV	Conversion time	VCC = 4.5 to 5.5 V, f(XIN) = 8 MHz			12.5	μs	
VVREF	Defended welleng	Vcc = 2.7 to 4.0 V	2		Vcc	V	
VVREF	Reference voltage	Vcc = 4.0 to 5.5 V	0.5 Vcc		Vcc	7 V	
RLADDER	Ladder resistance		12	35	100	kΩ	
VIA	Analog input voltage		0		VREF	V	
IVREF	Reference input current	VREF = 5.0 V	50	143	416	μΑ	

Note: -40 to 85 °C for extended operating temperature range version.





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

M37481M4/M8/E8-XXXSP/FP, M37481M2T/M4T/M8T/E8T-XXXSP/FP, M37481E8SS ABSOLUTE MAXIMUM RATINGS (7481 Group)

Table 12. Absolute maximum ratings

Symbol	Parameter	Condition	Rated value	Unit
Vcc	Power source voltage	All voltages are measured on the basis	-0.3 to 7	V
Vı	Input voltage	of the Vss pin.	-0.3 to Vcc + 0.3	V
Vo	Output voltage	Output transistors are cut off.	-0.3 to Vcc + 0.3	V
Pd	Power dissipation	Ta = 25 °C	1000 (Note 1)	mW
Topr	Operating temperature range		-20 to 85 (Note 2)	°C
Tstg	Storage temperature		-40 to 150 (Note 3)	°C

Notes 1:500 mW for 44P6N-A package type.

2: -40 to 85 °C for extended operating temperature range version.

3:-65 to 150 °C for extended operating temperature range version.

RECOMMENDED OPERATING CONDITIONS (7481 Group)

 $(VCC = 2.7 \text{ to } 5.5 \text{ V}, \text{V} \text{SS} = 0 \text{ V}, \text{Ta} = -20 \text{ to } 85^{\circ}\text{C} \text{ (Note 1) unless otherwise specified)}$

Table 13. Recommended operating conditions

Commando a l	Symbol Parameter		Sta	andard val	ues	Unit
Symbol	Parameter		Min.	Тур.	Max.	Unit
Vcc	Dougar course voltage	f(XIN) = (2.2VCC - 2) MHz	2.7	3	4.5	V
VCC	Power source voltage	f(XIN) = 8 MHz	4.5	5	5.5	V
Vss	Power source voltage	•		0		V
VIH	"H" input voltage P00 - P07, P10 - P17		0.8 Vcc		Vcc	V
VIH	"H" input voltage P20 – P27		0.7 Vcc		Vcc	V
ViH	"I " input voltogo D2o D2o	Vcc = 4.5 to 5.5 V	0.8 Vcc		Vcc	V
VIH	"H" input voltage P30 – P33	Vcc = 2.7 to 4.5 V	0.9 Vcc		Vcc	V
ViH	"H" input voltage P40 – P43, P50 – P53 (Note 4)	Vcc = 4.5 to 5.5 V	0.8 Vcc		Vcc	V
VIH	n input voltage F40 = F43, F30 = F33 (Note 4)	Vcc = 2.7 to 4.5 V	0.9 Vcc		Vcc	V
VIH	"H" input voltage XIN, RESET		0.8 Vcc		Vcc	V
VIL	"L" input voltage P00 - P07, P10 - P17		0		0.2 Vcc	V
VIL	"L" input voltage P20 – P27		0		0.25 Vcc	V
VIL	"L" input voltage P30 – P33	Vcc = 4.5 to 5.5 V	0		0.4 Vcc	V
VIL	L input voitage F30 – F33	Vcc = 2.7 to 4.5 V	0		0.3 Vcc	V
VIL	"L" input voltage P40 – P43, P50 – P53	VCC = 4.5 to 5.5 V	0		0.4 Vcc	V
VIL	L input voitage F40 – F43, F50 – F53	Vcc = 2.7 to 4.5 V	0		0.3 Vcc	V
VIL	"L" input voltage XIN		0		0.16 Vcc	V
VIL	"L" input voltage RESET		0		0.12 Vcc	V
lı	Input current P40 - P43, P50 - P53 (Note 4) VI >	Vcc			1	mA
IOH(sum)	"H" sum output current P00 - P07				-30	mA
IOH(sum)	"H" sum output current P10 - P17				-30	mA
IOL(sum)	"L" sum output current P00 - P07, P40 - P43, P5	0 – P52			60	mA
IOL(sum)	"L" sum output current P10 – P17, P53	"L" sum output current P10 – P17, P53			60	mA
IOH(peak)	"H" peak output current P00 – P07, P10 – P17				-10	mA
IOL(peak)	"L" peak output current P00 - P07, P10 - P17, P4	"L" peak output current P00 – P07, P10 – P17, P40 – P43, P50 – P53			20	mA
IOH(avg)	"H" average output current P00 - P07, P10 - P17	(Note 2)			-5	mA
IOL(avg)	"L" average output current P00 – P07, P10 – P17, P40	- P43, P50 - P53 (Note 2)			10	mA



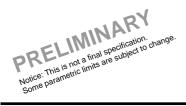


Table 13. Recommended operating conditions (cont.)

Cymphol	Devenden			St	Unit				
Symbol		Parameter			Тур.	Max.	Onit		
f(CNTD)	Timer input frequency CN	NTR0 (P40),	f(XIN) = 4 MHz			1	MHz		
f(CNTR) CNTR1 (P41) (Note 3)			f(XIN) = 8 MHz			2	IVITIZ		
		Clock synchronous	f(XIN) = 4 MHz			250	kHz		
f(Sclk)		serial I/O mode	f(XIN) = 8 MHz			500	KHZ		
I (SCLK)		LIADT	f(XIN) = 4 MHz			1	MHz		
		UART mode	f(XIN) = 8 MHz			2	IVITZ		
f(VINI)	Clock input oscillation frequency (Note 3)		Vcc = 2.7 to 4.5 V			2.2Vcc-2	MHz		
f(XIN)	Clock input oscillation ne	equency (Note 3)	Vcc = 4.5 to 5.5 V			8	IVITIZ		

Notes 1: -40 to 85 °C for extended operating temperature range version.

- 2: The average output currents IOH(avg) and IOL(avg) are the average values during 100 ms.
- 3: The clock input oscillation frequency is at 50 % duty ratio.
- 4: When applying a voltage through a resistor as shown in the figure 55, VI > VCC may be accepted if the current is 1 mA or less.

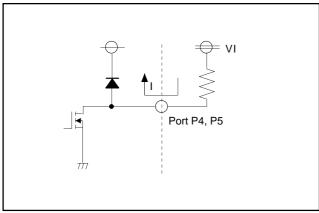


Fig. 55 Notes on use of ports P4 and P5

Notes on Clamp Diode (7481 Group)

(1) Total input current

The current of ports P4 and P5 through the clamp diode can be drawn up to 1.0 mA per port. When a current that cannot be consumed by microcomputer is sent flow to the clamp diode, this may raise the power source pin voltage of the microcomputer.

The system power circuit must be designed so that the power source voltage of the microcomputer may be stabilized within the standard values.

(2) Maximum input voltage

If the input voltage of a signal connected to ports P4 and P5 is beyond Vcc + 0.3 V, the input waveform should have a delay exceeding 2 μ s/V from the moment that this waveform goes over the voltage.

For using a CR circuit for delay, calculate a proper delay value by the following expression:

$$\frac{dt}{dv} = \frac{t}{0.6 \times VIN} \ge 2 \times 10^{-6} \text{ (s/V)}$$

where VIN = Maximum input voltage amplitude margin and $t = C \times R$.

The clamp diode of the 7480/7481 group is designed for a level shift of DC signal unlike ordinary switching diodes. Do not apply sudden stress, such as rush current, directly to the diode.

Notes on Countermeasures for Noise and Latch-up (7481 Group)

- (1) Connect a bypass capacitor (0.1 µF) across the Vcc pin and the Vss pin with the shortest possible wiring, using a relatively thick wire
- (2) Connect a bypass capacitor (0.01 μ F) across the VREF pin and the Vss pin with the shortest possible wiring, using a relatively thick wire
- (3) In the oscillation circuit, connect across the XIN and XOUT pins with the shortest possible wiring. Connect the GND and Vss pins of the oscillation circuit with the shortest possible wiring, using a relatively thick wire.
- (4) In the case of the P33/VPP pin of the built-in programmable ROM version, connect an approximately 5 k Ω resistor to the P33/VPP pin the shortest possible in series.





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

M37481M4/M8/E8-XXXSP/FP, M37481M2T/M4T/M8T/E8T-XXXSP/FP, M37481E8SS ELECTRICAL CHARACTERISTICS (7481 Group)

(Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85 °C (Note 1) unless otherwise specified)

Table 14. Electrical characteristics

Symbol	Doromotor	Toot conditions	St	Unit				
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Onic		
1/2	"H" output voltage	VCC = 5 V, IOH = -5 mA	3			V		
Vон	P00 – P07, P10 – P17	VCC = 3 V, IOH = -1.5 mA		2			\ \	
	"L" output voltage P00 - P07,	VCC = 5 V, IOL = 10 mA				2	V	
Vol	P10 – P17, P40 – P43, P50 – P53	VCC = 3 V, IOL = 3 mA				1	\ \	
\/- \/-	Hysteresis P00 – P07, (Note 2)	Vcc = 5 V			0.5		V	
VT + - VT-	P30 – P33, P40 – P43, P50 – P53	Vcc = 3 V			0.3		V	
\/- \/-	Harton is Data/Ones Data/DuD	When used as SCLK, RxD	Vcc = 5 V		0.5		.,	
VT + - VT-	Hysteresis P16/Sclk, P14/RxD	input	Vcc = 3 V		0.3		V	
\/_ \/_		Vcc = 5 V	'		0.5		.,	
VT + - VT-	Hysteresis RESET	Vcc = 3 V		0.3		V		
	"H" input current	VI = VCC without pull-up	Vcc = 5 V			5		
IIН	P00 – P07, P10 – P17	transistor	Vcc = 3 V			3	μΑ	
1	"H" input current	VI = VCC = 5 V	1			5		
lін	P30 – P33, P40 – P43, P50 – P53	VI = VCC = 3 V			3	μA		
	// // // / / / / / / / / / / / / / / /	VI = VCC when analog	Vcc = 5 V			5		
lін	"H" input current P20 – P27	input is not selected	Vcc = 3 V			3	μΑ	
	(1 m)	VI = VCC	Vcc = 5 V			5		
lін	"H" input current RESET, XIN	(XIN at stop)	Vcc = 3 V			3	— μA	
		VI = 0 V without pull-up	Vcc = 5 V			-5		
L	"L" input current P00 - P07,	transistor	Vcc = 3 V			-3	μΑ	
liL	P10 – P17	VI = 0 V with pull-up	Vcc = 5 V	-0.25	-0.5	-1.0		
		transistor (Note 3)	Vcc = 3 V	-0.08	-0.18	-0.35	mA	
I	"L" input current P30 - P33,		Vcc = 5 V			- 5		
lıL	P40 - P43, P50 - P53	VI = 0 V				-3	μΑ	
I	(II II)	VI = 0 V when analog input	Vcc = 5 V			-5		
lıL	"L" input current P20 – P27	is not selected	Vcc = 3 V			-3	μA	
L	(I)	VI = 0 V	Vcc = 5 V			-5		
lıL	"L" input current RESET, XIN	(XIN at stop)	Vcc = 3 V			-3	μA	

Notes 1: -40 to 85 °C for extended operating temperature range version.

When VCC = 5 V: 5 k Ω (min.), 10 k Ω (typ.), 20 k Ω (max.).

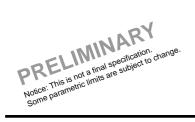
When VCC = 3 V: 8.6 k Ω (min.), 16.7 k Ω (typ.), 37.5 k Ω (max.).



^{2:} Using P0 for key-on wake-up function.

^{3 :} Can be indicated in resistance value as shown below:





M37481M4/M8/E8-XXXSP/FP, M37481M2T/M4T/M8T/E8T-XXXSP/FP, M37481E8SS

Table 14. Electrical characteristics (cont.)

Symbol	Parameter		Test conditions			Standard values			
Symbol	Faiailielei		Test conditions			Тур.	Max.	Unit	
VRAM	RAM retention voltage	At	clock stop mode	2			V		
			In high-speed mode, f(XIN) = 4 MHz,	A-D conversion not executed		3.5	7	mA	
			VCC = 5 V	A-D conversion in progress		4	8	mA	
			In high-speed mode,	A-D conversion not executed		1.8	3.6	m.A	
			f(XIN) = 4 MHz, $VCC = 3 V$	A-D conversion in progress		2	4	mA	
		de	In high-speed mode, f(XIN) = 8 MHz,	A-D conversion not executed		7	14	m <i>A</i>	
		ing mo	VCC = 5 V	A-D conversion in progress		7.5	15	m/	
	Power source current	In operating mode	In medium-speed mode, f(XIN) = 4 MHz,	A-D conversion not executed		1.75	3.5	m/	
			VCC = 5 V	A-D conversion in progress		2	4	m/	
			In medium-speed mode, f(XIN) = 4 MHz, VCC = 3 V	A-D conversion not executed		0.9	1.8	m/	
				A-D conversion in progress		1	2	m/	
Icc			In medium-speed mode, f(XIN) = 8 MHz, VCC = 5 V	A-D conversion not executed		3.5	7	m/	
				A-D conversion in progress		3.75	7.5	m/	
		mode	In high-speed mode, f(XIN) = 4 MHz	Vcc = 5 V		1	2	mA	
				Vcc = 3 V		0.5	1		
			In high-speed mode, f(XIN) = 8 MHz	Vcc = 5 V		2	4		
		In wait 1	In medium-speed	Vcc = 5 V		0.9	1.8		
			mode, f(XIN) = 4 MHz	Vcc = 3 V		0.45	0.9	m/	
			In medium-speed mode, f(XIN) = 8 MHz	Vcc = 5 V		1.8	3.6		
		stop mode	f(XIN) = 0	Ta = 25 °C		0.1	1	μA	
		n stop	Vcc = 5 V	Ta = 85 °C		1	10	μΔ	





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

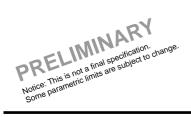
M37481M4/M8/E8-XXXSP/FP, M37481M2T/M4T/M8T/E8T-XXXSP/FP, M37481E8SS A-D CONVERSION CHARACTERISTICS (7481 Group)

(Vcc = 2.7 to 5.5 V, Vss = 0 V, Ta = -20 to 85°C (Note) unless otherwise specified)

Table 15. A-D conversion characteristics

Cumbal	Parameter	Test conditions	St	Standard values			
Symbol	Parameter	rest conditions	Min.	Тур.	Max.	Unit	
	Resolution				8	bits	
	Absolute accuracy (except quantization error)	VCC = VREF = 5.0 V			±2	LSB	
TCONV	Conversion time	Vcc = 2.7 to 5.5 V, f(XIN) = 4 MHz			25		
TCONV	Conversion time	Vcc = 4.5 to 5.5 V, f(XIN) = 8 MHz			12.5	μs	
Vvref	Deference voltege	Vcc = 2.7 to 4.0 V			Vcc	V	
VVKEF	Reference voltage	Vcc = 4.0 to 5.5 V	0.5 Vcc		Vcc] v	
RLADDER	Ladder resistance		12	35	100	kΩ	
VIA	Analog input voltage		0		VREF	V	
IVREF	Reference input current	VREF = 5.0 V	50	143	416	μΑ	

Note: -40 to 85 °C for extended operating temperature range version.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

MASK ROM CONFIRMATION FORM

GZZ-SH09-84B<56A0>

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480M2T-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
	Section head	Supervisor
ei.	signature	signature
Receipt		
"		

Note: Please fill in all items marked *..

		Company		TEL		ФФ	Submitted by	Supervisor
*	Customer	name		()	uano natur		
		Date issued	Date:			Issi sigi		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :	☐ M37480M2T-XXXSP			M	37480	. P		
	Checks	um code for entire EPRC	ОМ					(hexadecimal notation)

EPROM type (indicate the type used)

	27128		27256		27512
EPROM ac	ddress	EPROM a	ddress	EPROM ac	ddress
0000 ₁₆	Area for ASCII codes of the name of the product 'M37480M2T-'	0000 ₁₆	Area for ASCII codes of the name of the product 'M37480M2T-'	0000 ₁₆	Area for ASCII codes of the name of the product 'M37480M2T-'
001016		001016		001016	
2FFF ₁₆ 3000 ₁₆		6FFF ₁₆ 7000 ₁₆		EFFF ₁₆ F000 ₁₆	
	ROM (4K)		ROM (4K)		ROM (4K)
3FFF ₁₆		7FFF ₁₆		FFFF ₁₆	

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37480M2T-' to addresses 000016 to 000F16. ASCII codes 'M37480M2T-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 ₁₆
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'0' = 30 ₁₆
000616	'M' = 4D ₁₆
000716	'2' = 32 ₁₆

Address	
000816	'T'=54 ₁₆
000916	' – ' = 2D ₁₆
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF ₁₆







GZZ-SH09-84B<56A0>

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740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480M2T-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the start address of the assembler source program.

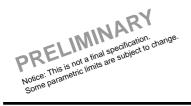
EPROM type	27128	27256	27512
The pseudo-command	* = △\$C000	* =△\$8000	* =△\$0000
	△.BYTE △'M37480M2T–'	△.BYTE △'M37480M2T–'	△.BYTE△'M37480M2T–'

Note: If the name of the product written to the EPROMs does not match the name of the mask confirmation, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered fill out the appropriate mark specification form (32P4B for M37480M2T-XXXSP, 32P2W-A for M37480M2T-XXXFP) and attach to the mask ROM confirmation form.

3. Comments



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-85B<56A0>

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480M4-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
	Section head	Supervisor
eceipt	signature	signature
ece		
<u> </u>		

Note: Please fill in all items marked *.

		Company		TEL		Ф Ф	Submitted by	Supervisor
*	Customer	name		()	uanc natur		
		Date issued	Date:			Issi sigi		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :	M37480M4-XXXSP	M37480M4-XXXFP

Checksum code for entire EPROM			(hexadecimal notation)

EPROM type (indicate the type used)

	27128		27256		27512
EPROM ac	ddress	EPROM ad	ddress	EPROM a	ddress
000016	Area for ASCII codes of the name of the product 'M37480M4-'	000016	Area for ASCII codes of the name of the product 'M37480M4-'	000016	Area for ASCII codes of the name of the product 'M37480M4'
000F ₁₆ 0010 ₁₆		000F ₁₆ 0010 ₁₆		000F ₁₆ 0010 ₁₆	
1FFF ₁₆ 2000 ₁₆		5FFF ₁₆ 6000 ₁₆		DFFF ₁₆ E000 ₁₆	
	ROM (8K)		ROM (8K)		ROM (8K)
3FFF ₁₆		7FFF ₁₆		FFFF ₁₆	

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37480M4-' to addresses 000016 to 000F16. ASCII codes 'M37480M4-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 ₁₆
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'0' = 3016
000616	'M' = 4D ₁₆
000716	'4' = 34 ₁₆

Address	
000816	' – ' = 2D ₁₆
000916	FF ₁₆
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF ₁₆









GZZ-SH09-85B<56A0>

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740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480M4-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the start address of the assembler source program.

EPROM type	27128	27256	27512
The pseudo-command	* =△\$C000	* =△\$8000	* =△\$0000
	△.BYTE △'M37480M4–'	△BYTE △'M37480M4–'	△.BYTE△'M37480M4–'

Note: If the name of the product written to the EPROMs does not match the name of the mask confirmation, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered fill out the appropriate mark specification form (32P4B for M37480M4-XXXSP, 32P2W-A for M37480M4-XXXFP) and attach to the mask ROM confirmation form.

*** 3. Comments**



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-86B<56A0>

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480M4T-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
<u> </u>	Section head	Supervisor
eceipt	signature	signature
Sec		
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Note: Please fill in all items marked *.

		Company		TEL		Ф Ф	Submitted by	Supervisor
*	Customer	name		()	uanc natur		
		Date issued	Date:			Issi sigi		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :	M37480M4T-XXXSP	M37480M4T-XXXFF

Checksum code for entire EPROM			(hexadecimal notation)

EPROM type (indicate the type used)

ET IXON LY	pe (maicate the	ypo dood)			
	27128		27256		27512
EPROM a	ddress	EPROM a	EPROM address		ddress
000016	Area for ASCII codes of the name of the product	000016	Area for ASCII codes of the name of the product	000016	Area for ASCII codes of the name of the product
000F ₁₆ 0010 ₁₆	'M37480M4T-'	000F ₁₆ 0010 ₁₆	'M37480M4T-'	000F ₁₆ 0010 ₁₆	'M37480M4T-'
1FFF ₁₆ 2000 ₁₆		5FFF ₁₆ 6000 ₁₆		DFFF ₁₆ E000 ₁₆	
	ROM (8K)		ROM (8K)		ROM (8K)
3FFF ₁₆		7FFF ₁₆		FFFF ₁₆	

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37480M4T-' to addresses 000016 to 000F16. ASCII codes 'M37480M4T-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 16
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'0' = 30 ₁₆
000616	'M' = 4D ₁₆
000716	'4' = 34 ₁₆

0008 ₁₆ 'T' = 54 ₁₆	_
000016 1 = 3416	6
0009_{16} $'-'=2D_1$	
000A ₁₆ FF ₁	6
000B ₁₆ FF ₁	6
000C ₁₆ FF ₁	6
000D ₁₆ FF ₁	6
000E ₁₆ FF ₁₀	6
000F ₁₆ FF ₁₀	6







GZZ-SH09-86B<56A0>

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740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480M4T-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the start address of the assembler source program.

EPROM type	27128	27256	27512
The pseudo-command	*= △\$C000	*= △\$8000	*= △\$0000
	△.BYTE△'M37480M4T–'	△.BYTE △'M37480M4T–'	△.BYTE △'M37480M4T–'

Note: If the name of the product written to the EPROMs does not match the name of the mask confirmation, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered fill out the appropriate mark specification form (32P4B for M37480M4T-XXXSP, 32P2W-A for M37480M4T-XXXFP) and attach to the mask ROM confirmation form.

*** 3. Comments**



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-87B<56A0>

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480M8-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
	Section head	Supervisor
eceipt	signature	signature
ece		
<u> </u>		

Note: Please fill in all items marked *.

		Company		TEL		Ф Ф	Submitted by	Supervisor
*	Customer	name		()	uanc natur		
		Date issued	Date:			Issi sigi		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name:	M37480M8-XXXSP	M37480M8-XXXFP

Checksum code for entire EPROM (hexadecimal notation)

EPROM type (indicate the type used)

	27256		27512
EPROM ac	ddress	EPROM ad	ddress
000016 000F16	Area for ASCII codes of the name of the product 'M37480M8-'	0000 ₁₆	Area for ASCII codes of the name of the product 'M37480M8-'
001016		001016	
3FFF ₁₆		BFFF ₁₆	
400016		C000 ₁₆	
	ROM (16K)		ROM (16K)
7FFF ₁₆		FFFF ₁₆	

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37480M8-' to addresses 000016 to 000F16. ASCII codes 'M37480M8-' are listed on the right. The addresses and data are in hexadecimal notation.

Address		
000016	'M' = 4D ₁₆	
000116	'3' = 33 ₁₆	
000216	'7' = 37 ₁₆	
000316	'4' = 34 ₁₆	
000416	'8' = 38 ₁₆	
000516	'0' = 30 ₁₆	
000616	'M' = 4D ₁₆	
000716	'8' = 38 ₁₆	

Address	
000816	' – ' = 2D ₁₆
000916	FF ₁₆
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF ₁₆





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-87B<56A0>

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740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480M8-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the assembler source file:

EPROM type	27256	27512
The pseudo-command	* =△\$8000 △BYTE △'M37480M8-'	* =△\$0000 △BYTE △'M37480M8-'

Note: If the name of the product written to the EPROMs does not match the name of the mask confirmation, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered fill out the appropriate mark specification form (32P4B for M37480M8-XXXSP, 32P2W-A for M37480M8-XXXFP) and attach to the mask ROM confirmation form.

*** 3. Comments**



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-88B<56A0>

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480M8T-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
	Section head	Supervisor
ei Bi	signature	signature
Receipt		
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Note: Please fill in all items marked *.

		Company		TEL		Ф Ф	Submitted by	Supervisor
*	Customer	name		()	uanc natur		
		Date issued	Date:			Issi sigi		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name:	M37480M8T-XXXSP	M37480M8T-XXXFF

Checksum code for entire EPROM			(hexadecimal notation)

EPROM type (indicate the type used)

El Now type (maleate the type asea)						
	27256			27512		
EPROM a	ddress		EPROM ac	ddress		
000016	Area for ASCII codes of the name of the product		000016	Area for ASCII codes of the name of the product		
000F ₁₆ 0010 ₁₆	'M37480M8T-'		000F ₁₆ 0010 ₁₆	'M37480M8T-'		
3FFF ₁₆ 4000 ₁₆			BFFF ₁₆ C000 ₁₆			
	ROM (16K)			ROM (16K)		
7FFF ₁₆			FFFF ₁₆			

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37480M8T-' to addresses 000016 to 000F16. ASCII codes 'M37480M8T-' are listed on the right. The addresses and data are in hexadecimal notation.

Address		
000016	'M' = 4D ₁₆	
000116	'3' = 33 ₁₆	
000216	'7' = 37 ₁₆	
000316	'4' = 34 ₁₆	
000416	'8' = 38 ₁₆	
000516	'0' = 30 ₁₆	
000616	'M' = 4D ₁₆	
000716	'8' = 38 ₁₆	

Address	
000816	'T'=5416
000916	' – ' = 2D ₁₆
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF ₁₆





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-88B<56A0>

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740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480M8T-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the assembler source file:

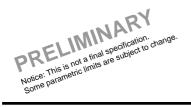
EPROM type	27256	27512
The pseudo-command	* =△\$8000 △.BYTE △'M37480M8T-'	* =△\$0000 △.BYTE △'M37480M8T-'

Note: If the name of the product written to the EPROMs does not match the name of the mask confirmation, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered fill out the appropriate mark specification form (32P4B for M37480M8T-XXXSP, 32P2W-A for M37480M8T-XXXFP) and attach to the mask ROM confirmation form.

*** 3. Comments**



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-78B<56A0>

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481M2T-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
<u> </u>	Section head	Supervisor
eceipt	signature	signature
Sec		
Ľ.		

Note: Please fill in all items marked *.

		Company		TEL		o o	Submitted by	Supervisor
*	Customer	name		()	anc atur		
-		Date issued	Date:			lssu sigr		

* 1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :	☐ M37481M2T-XXXSP			M	37481	M2T-	XXXF	₽
	Checks	sum code for entire EPRO	мГ					(hexadecimal notation)

	27128		27256		27512
EPROM ac	ddress	EPROM a	ddress	EPROM a	ddress
0000 ₁₆	Area for ASCII codes of the name of the product 'M37481M2T-'	0000 ₁₆	Area for ASCII codes of the name of the product 'M37481M2T-'	0000 ₁₆	Area for ASCII codes of the name of the product 'M37481M2T-'
001016		001016		001016	
2FFF ₁₆ 3000 ₁₆		6FFF ₁₆ 7000 ₁₆		EFFF ₁₆ F000 ₁₆	
	ROM (4K)		ROM (4K)		ROM (4K)
3FFF ₁₆		7FFF ₁₆		FFFF ₁₆	

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37481M2T-' to addresses 000016 to 000F16. ASCII codes 'M37481M2T-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 ₁₆
000316	'4' = 3416
000416	'8' = 38 ₁₆
000516	'1' = 31 ₁₆
000616	'M' = 4D ₁₆
000716	'2' = 32 ₁₆

Address	
000816	'T'=54 ₁₆
000916	' – ' = 2D ₁₆
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF16





GZZ-SH09-78B<56A0>

Mask ROM number	
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740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481M2T-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the start address of the assembler source program.

EPROM type	27128	27256	27512
The pseudo-command	* =△\$C000	*= △\$8000	* = △\$0000
	△BYTE △'M37481M2T–'	△BYTE△'M37481M2T–'	△BYTE △ 'M37481M2T–'

Note: If the name of the product written to the EPROMs does not match the name of the mask confirmation, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered fill out the appropriate mark specification form (42P4B for M37481M2T-XXXSP, 44P6N-A for M37481M2T-XXXFP) and attach to the mask ROM confirmation form.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-79B<56A0>

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481M4-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
eipt	Section head signature	Supervisor signature
Receipt		

Note: Please fill in all items marked *.

		Company		TEL		o o	Submitted by	Supervisor
*	Customer	name		()	anc atur		
-		Date issued	Date:			lssu sigr		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :		M37481M4-XXXSP		N	137481	M4-X	XXFP	
	Checks	sum code for entire EPR	ом [(hexadecimal notation)

	07400		07050		7 07540
	27128		27256		27512
EPROM a	ddress	EPROM a	ddress	EPROM	address
000016	Area for ASCII codes of the name of the product	000016	Area for ASCII codes of the name of the product	000016	Area for ASCII codes of the name of the product
000F ₁₆ 0010 ₁₆	'M37481M4-'	000F ₁₆ 0010 ₁₆	'M37481M4-'	000F ₁₆	
1FFF ₁₆ 2000 ₁₆		5FFF ₁₆ 6000 ₁₆		DFFF16 E00016	
	ROM (8K)		ROM (8K)		ROM (8K)
3FFF ₁₆		7FFF ₁₆		FFFF16	3

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37481M4-' to addresses 000016 to 000F16. ASCII codes 'M37481M4-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 ₁₆
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'1' = 31 ₁₆
000616	'M' = 4D ₁₆
000716	'4' = 34 ₁₆

Address	
000816	' – ' = 2D ₁₆
000916	FF ₁₆
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF16





GZZ-SH09-79B<56A0>

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740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481M4-XXXSP/FP MITSUBISHI ELECTRIC

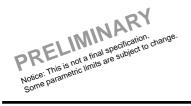
Recommend to writing the following pseudo-command to the start address of the assembler source program.

EPROM type	27128	27256	27512
The pseudo-command	* =△\$C000	* =△\$8000	* = △\$0000
	△BYTE△'M37481M4–'	△.BYTE△'M37481M4–'	△.BYTE △ 'M37481M4–'

Note: If the name of the product written to the EPROMs does not match the name of the mask confirmation, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered fill out the appropriate mark specification form (42P4B for M37481M4-XXXSP, 44P6N-A for M37481M4-XXXFP) and attach to the mask ROM confirmation form.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-80B<56A0>

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481M4T-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
eipt	Section head signature	Supervisor signature
Receipt		

Note: Please fill in all items marked *.

		Company		TEL		o o	Submitted by	Supervisor
*	Customer	name		()	anc atur		
-		Date issued	Date:			lssu sigr		

* 1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :		M37481M4T-XXXSP		M37	7481M4	T-X	(XXFI	Р
	Checks	sum code for entire EPRON	1					(hexadecimal notation)

	27128		27256		27512
EPROM ac	ddress	EPROM a	ddress	EPROM a	ddress
0000 ₁₆	Area for ASCII codes of the name of the product 'M37481M4T-'	0000 ₁₆	Area for ASCII codes of the name of the product 'M37481M4T-'	0000 ₁₆	Area for ASCII codes of the name of the product 'M37481M4T-'
001016		001016		001016	
1FFF ₁₆ 2000 ₁₆		5FFF ₁₆ 6000 ₁₆		DFFF ₁₆ E000 ₁₆	
	ROM (8K)		ROM (8K)		ROM (8K)
3FFF ₁₆		7FFF ₁₆		FFFF ₁₆	

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37481M4T-' to addresses 000016 to 000F16. ASCII codes 'M37481M4T-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 ₁₆
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'1' = 31 ₁₆
000616	'M' = 4D ₁₆
000716	'4' = 34 ₁₆

' T ' = 54 ₁₆
' – ' = 2D ₁₆
FF ₁₆
FF ₁₆
FF ₁₆
FF16
FF ₁₆
FF ₁₆





GZZ-SH09-80B<56A0>

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740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481M4T-XXXSP/FP MITSUBISHI ELECTRIC

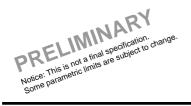
Recommend to writing the following pseudo-command to the start address of the assembler source program.

EPROM type	27128	27256	27512
The pseudo-command	* = △\$C000	* = △\$8000	*= △\$0000
	△.BYTE △'M37481M4T–'	△BYTE △'M37481M4T–'	△.BYTE △'M37481M4T–'

Note: If the name of the product written to the EPROMs does not match the name of the mask confirmation, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered fill out the appropriate mark specification form (42P4B for M37481M4T-XXXSP, 44P6N-A for M37481M4T-XXXFP) and attach to the mask ROM confirmation form.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-81B<56A0>

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481M8-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
	Section head	Supervisor
l je	signature	signature
Receipt		
<u>~</u>		
l		

Note: Please fill in all items marked *.

		Company		TEL		Ф Ф	Submitted by	Supervisor
*	Customer	name		()	uanc natur		
		Date issued	Date:			Issi sigi		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :		M37481M8-XXXSP	M37481M8-XXXFP
	ш		

Checksum code for entire EPROM			(hexadecimal notation)

	27256		27512
EPROM ac	ddress	EPROM ad	ddress
000016 000F16	Area for ASCII codes of the name of the product 'M37481M8-'	0000 ₁₆	Area for ASCII codes of the name of the product 'M37481M8-'
001016		001016	
3FFF ₁₆		BFFF ₁₆	
400016		C000 ₁₆	
	ROM (16K)		ROM (16K)
7FFF ₁₆		FFFF ₁₆	

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37481M8—' to addresses 0000₁₆ to 000F₁₆. ASCII codes 'M37481M8—' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 ₁₆
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'1' = 31 ₁₆
000616	'M' = 4D ₁₆
000716	'8' = 38 ₁₆

' – ' = 2D ₁₆
FF ₁₆
FF16







GZZ-SH09-81B<56A0>

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740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481M8-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the assembler source file:

EPROM type	27256	27512
The pseudo-command	* = △\$8000 △.BYTE△ 'M37481M8-'	* = △\$0000 △.BYTE △'M37481M8-'

Note: If the name of the product written to the EPROMs does not match the name of the mask confirmation, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered fill out the appropriate mark specification form (42P4B for M37481M8-XXXSP, 44P6N-A for M37481M8-XXXFP) and attach to the mask ROM confirmation form.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-82B<56A0>

Mask ROM number

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481M8T-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
eipt	Section head signature	Supervisor signature
Receipt		

Note: Please fill in all items marked *.

		Company		TEL		Ф Ф	Submitted by	Supervisor
*	Customer	name		()	uanc natur		
		Date issued	Date:			Issi sigi		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :	M37481M8T-XXXSP	M37481M8T-XXXFP

Ī			
Checksum code for entire EPROM			(hexadecimal notation)

	pe (maicate the	, ,,,,	o acca,		
	27256			27512	
EPROM a	ddress		EPROM address		
000016	Area for ASCII codes of the name of the product		000016	Area for ASCII codes of the name of the product	
000F ₁₆ 0010 ₁₆	'M37481M8T-'		000F ₁₆ 0010 ₁₆	'M37481M8T-'	
3FFF ₁₆ 4000 ₁₆			BFFF ₁₆ C000 ₁₆		
	ROM (16K)			ROM (16K)	
7FFF ₁₆			FFFF ₁₆		

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37481M8T-' to addresses 000016 to 000F16. ASCII codes 'M37481M8T-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 ₁₆
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'1' = 31 ₁₆
000616	'M' = 4D ₁₆
000716	'8' = 38 ₁₆

Address	
000816	' T ' = 54 ₁₆
000916	' – ' = 2D ₁₆
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF ₁₆







GZZ-SH09-82B<56A0>

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740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481M8T-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the assembler source file:

EPROM type	27256	27512
The pseudo-command	* =△\$8000 △.BYTE △'M37481M8T-'	* =△\$0000 △.BYTE △ 'M37481M8T-'

Note: If the name of the product written to the EPROMs does not match the name of the mask confirmation, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered fill out the appropriate mark specification form (42P4B for M37481M8T-XXXSP, 44P6N-A for M37481M8T-XXXFP) and attach to the mask ROM confirmation form.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

ROM PROGRAMMING CONFIRMATION FORM

GZZ-SH09-91B<56A0>

ROM number

740 FAMILY ROM PROGRAMMING CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480E8-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
əipt	Section head signature	Supervisor signature
Receipt		

Note: Please fill in all items marked *.

		Company		TEL		Ф Ф	Submitted by	Supervisor
*	Customer	name		()	uanc natur		
		Date issued	Date:			Issı sigr		

* 1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce ROM programming based on this data. We shall assume the responsibility for errors only if the ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :		M37480E8-XXXSP		M	37480	E8-X	XXFP	
	Checks	sum code for entire EPR	ом Г					(hexadecimal notation)

	27256		27512
EPROM ac	ddress	EPROM ad	ddress
0000 ₁₆	Area for ASCII codes of the name of the product 'M37480E8-'	0000 ₁₆	Area for ASCII codes of the name of the product 'M37480E8-'
001016		001016	
3FFF ₁₆ 4000 ₁₆		BFFF ₁₆ C000 ₁₆	
	ROM (16K)		ROM (16K)
7FFF ₁₆		FFFF ₁₆	

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37480E8-' to addresses 000016 to 000F16. ASCII codes 'M37480E8-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 16
000216	'7' = 37 ₁₆
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'0' = 30 ₁₆
000616	'E' = 4516
000716	'8' = 38 ₁₆

Address	
000816	' – ' = 2D ₁₆
000916	FF ₁₆
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF16







SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-91B<56A0>

ROM number	
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740 FAMILY ROM PROGRAMMING CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480E8-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the assembler source file:

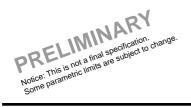
EPROM type	27256	27512
The pseudo-command	* = △\$8000 △BYTE △ 'M37480E8-'	* =△\$0000 △BYTE△'M37480E8-'

Note: If the name of the product written to the EPROMs does not match the name of the ROM programming confirmation form, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered. Please submit the shrink DIP package Mark Specification Form (only for built-in One Time PROM microcomputer) for the M37480E8-XXXSP or the 32P2W-A Mark Specification Form for the M37480E8-XXXFP.





GZZ-SH09-92B<56A0>

ROM number

740 FAMILY ROM PROGRAMMING CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480E8T-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
	Section head	Supervisor
e ipi	signature	signature
Receipt		
Ľ.		

Note: Please fill in all items marked *.

		Company		TEL		Ф Ф	Submitted by	Supervisor
*	Customer	name		()	uanc natur		
-		Date issued	Date:			Issi sigi		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce ROM programming based on this data. We shall assume the responsibility for errors only if the ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :		M37480E8T-XXXSP	M37480E8T-XXXFP

Checksum code for entire EPROM (hexadecimal notation)

Er Now type (indicate the type dised)						
	27256			27512		
EPROM ac	ddress		EPROM ac	ddress		
000016	Area for ASCII codes of the name of the product		000016	Area for ASCII codes of the name of the product		
000F ₁₆ 0010 ₁₆	'M37480E8T-'		000F ₁₆ 0010 ₁₆	'M37480E8T-'		
3FFF ₁₆ 4000 ₁₆			BFFF ₁₆ C000 ₁₆			
	ROM (16K)			ROM (16K)		
7FFF ₁₆			FFFF ₁₆			

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37480E8T-' to addresses 000016 to 000F16. ASCII codes 'M37480E8T-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 16
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'0' = 30 ₁₆
000616	'E' = 45 ₁₆
000716	'8' = 38 ₁₆

Address	
000816	' T ' = 54 ₁₆
000916	' – ' = 2D ₁₆
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF ₁₆





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-92B<56A0>

ROM number	
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740 FAMILY ROM PROGRAMMING CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37480E8T-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the assembler source file:

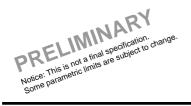
EPROM type	27256	27512
The pseudo-command	* = △\$8000 △.BYTE △'M37480E8T-'	* =△\$0000 △.BYTE △'M37480E8T-'

Note: If the name of the product written to the EPROMs does not match the name of the ROM programming confirmation form, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered. Please submit the shrink DIP package Mark Specification Form (only for built-in One Time PROM microcomputer) for the M37480E8T-XXXSP or the 32P2W-A Mark Specification Form for the M37480E8T-XXXFP.





GZZ-SH09-89B<56A0>

ROM number

740 FAMILY ROM PROGRAMMING CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481E8-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
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Rece		

Note: Please fill in all items marked *.

		Company		TEL		Ф Ф	Submitted by	Supervisor
*	Customer	name		()	uanc natur		
		Date issued	Date:			Issi sigi		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce ROM programming based on this data. We shall assume the responsibility for errors only if the ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :	M37481E8-XXXSP	M37481E8-XXXFP

Checksum code for entire EPROM			(hexadecimal notation)

□ 27256				27512
EPROM ac	ddress		EPROM ad	ddress
000016 000F16	Area for ASCII codes of the name of the product 'M37481E8-'		0000 ₁₆	Area for ASCII codes of the name of the product 'M37481E8-'
001016			001016	
3FFF ₁₆ 4000 ₁₆			BFFF ₁₆ C000 ₁₆	
430016	ROM (16K)		230016	ROM (16K)
7FFF ₁₆			FFFF ₁₆	

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37481E8-' to addresses 000016 to 000F16. ASCII codes 'M37481E8-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 16
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'1' = 31 ₁₆
000616	'E' = 45 ₁₆
000716	'8' = 38 ₁₆

Address	
000816	' – ' = 2D ₁₆
000916	FF ₁₆
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF16







GZZ-SH09-89B<56A0>

ROM number	
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740 FAMILY ROM PROGRAMMING CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481E8-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the assembler source file:

EPROM type	27256	27512
The pseudo-command	* = △\$8000 △BYTE △ 'M37481E8-'	* =△\$0000 △BYTE△'M37481E8-'

Note: If the name of the product written to the EPROMs does not match the name of the ROM programming confirmation form, the ROM processing is disabled. Write the data correctly.

* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered. Please submit the shrink DIP package Mark Specification Form (only for built-in One Time PROM microcomputer) for the M37481E8-XXXSP or the 44P6N-A Mark Specification Form for the M37481E8-XXXFP.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

GZZ-SH09-90B<56A0>

ROM number

740 FAMILY ROM PROGRAMMING CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481E8T-XXXSP/FP MITSUBISHI ELECTRIC

	Date:	
	Section head	Supervisor
e ipi	signature	signature
Receipt		
<u> </u>		

Note: Please fill in all items marked *.

		Company		TEL		Ф Ф	Submitted by	Supervisor
*	Customer	name		()	uanc natur		
		Date issued	Date:			Issi sigi		

1. Confirmation

Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern (Check @ in the appropriate box).

If at least two of the three sets of EPROMs submitted contain identical data, we will produce ROM programming based on this data. We shall assume the responsibility for errors only if the ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Microcomputer name :	M37481E8T-XXXSP		M37481E8T-XXXFP
		_	

Checksum code for entire EPROM (hexadecimal notation)

Er Now type (indicate the type used)					
	27256			27512	
EPROM a	ddress		EPROM address		
000016	Area for ASCII codes of the name of the product		000016	Area for ASCII codes of the name of the product	
000F ₁₆ 0010 ₁₆	'M37481E8T-'		000F ₁₆ 0010 ₁₆	'M37481E8T-'	
3FFF ₁₆ 4000 ₁₆			BFFF ₁₆ C000 ₁₆		
	ROM (16K)			ROM (16K)	
7FFF ₁₆			FFFF ₁₆		

- (1) Set "FF16" in the shaded area.
- (2) Write the ASCII codes that indicates the name of the product 'M37481E8T-' to addresses 000016 to 000F16. ASCII codes 'M37481E8T-' are listed on the right. The addresses and data are in hexadecimal notation.

Address	
000016	'M' = 4D ₁₆
000116	'3' = 33 ₁₆
000216	'7' = 37 ₁₆
000316	'4' = 34 ₁₆
000416	'8' = 38 ₁₆
000516	'1' = 31 ₁₆
000616	'E' = 45 ₁₆
000716	'8' = 38 ₁₆

Address 0008 ₁₆ 0009 ₁₆ 000A ₁₆	'T' = 5416 '-' = 2D16 FF16
,	' T ' = 54 ₁₆
000916	$' - ' = 2D_{16}$
000A ₁₆	FF ₁₆
000B ₁₆	FF ₁₆
000C ₁₆	FF ₁₆
000D ₁₆	FF ₁₆
000E ₁₆	FF ₁₆
000F ₁₆	FF ₁₆







GZZ-SH09-90B<56A0>

ROM number	
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740 FAMILY ROM PROGRAMMING CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37481E8T-XXXSP/FP MITSUBISHI ELECTRIC

Recommend to writing the following pseudo-command to the assembler source file:

EPROM type	27256	27512
The pseudo-command	* = △\$8000 △BYTE △'M37481E8T-'	* =△\$0000 △BYTE △'M37481E8T-'

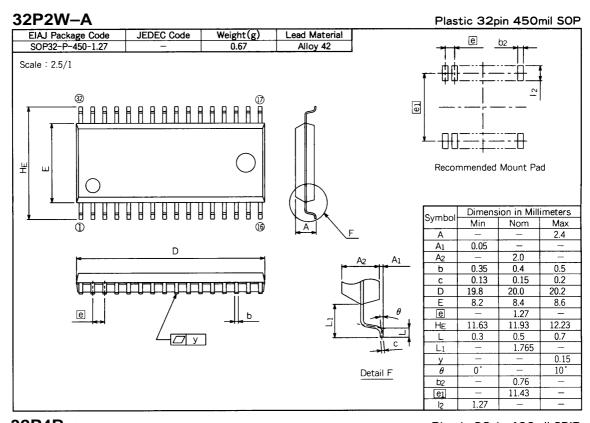
Note: If the name of the product written to the EPROMs does not match the name of the ROM programming confirmation form, the ROM processing is disabled. Write the data correctly.

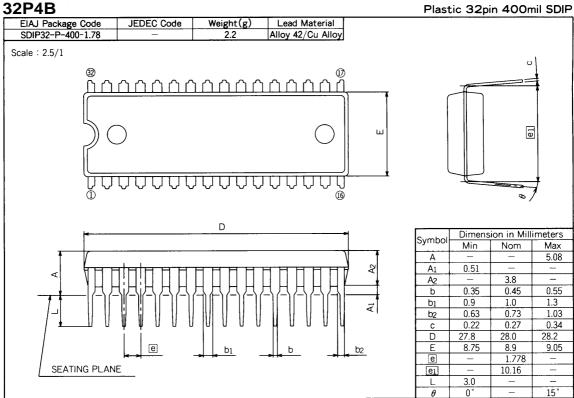
* 2. Mark specification

Mark specification must be submitted using the correct form for the package being ordered. Please submit the shrink DIP package Mark Specification Form (only for built-in One Time PROM microcomputer) for the M37481E8T-XXXSP or the 44P6N-A Mark Specification Form for the M37481E8T-XXXFP.

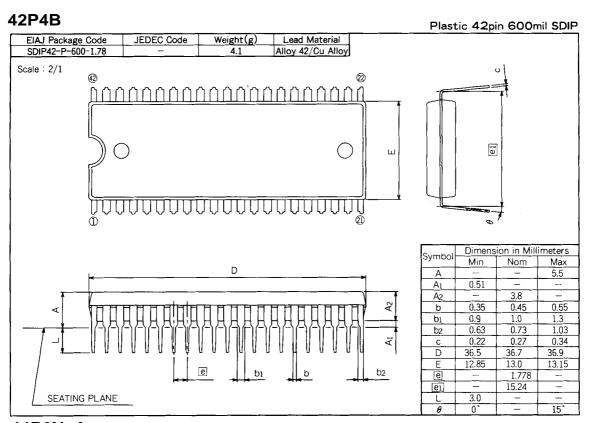


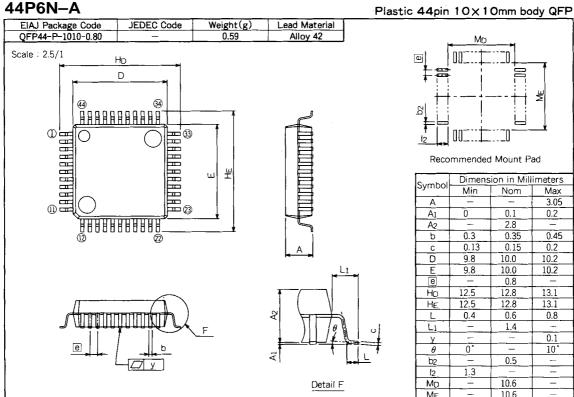
PACKAGE OUTLINE













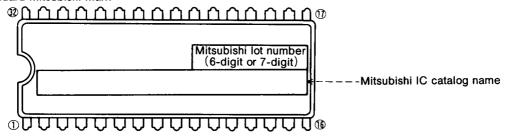
MARK SPECIFICATION FORM

32P4B (32-PIN SHRINK DIP) MARK SPECIFICATION FORM

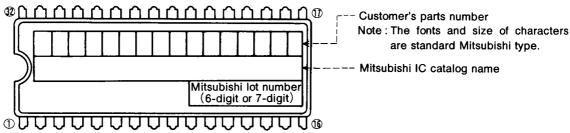
Mitsubishi IC catalog name

Please choose one of the marking types below (A, B, C), and enter the Mitsubishi IC catalog name and the special mark (if needed).

A. Standard Mitsubishi Mark



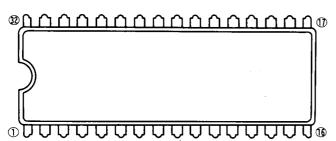
B. Customer's Parts Number + Mitsubishi Catalog Name



Note1: The mark field should be written right aligned.

- 2: The fonts and size of characters are standard Mitsubishi type.
- 3: Customer's parts number can be up to 16 characters: Only $0\sim9$, $A\sim Z$, +, -, /, (,), &, \bigcirc , . (period), and , (comma) are usable.

C. Special Mark Required



- Note1: If the special mark is to be printed, indicate the desired layout of the mark in the upper figure. The layout will be duplicated as close as possible. Mitsubishi lot number (6-digit or 7-digit) and mask ROM number (3-digit) are always marked.
 - 2: If the customer's trade mark logo must be used in the special mark, check the box below. Please submit a clean original of the logo.

For the new special character fonts a clean font original (ideally logo drawing) must be submitted.

Special logo required

The standard Mitsubishi font is used for all characters except for a logo.



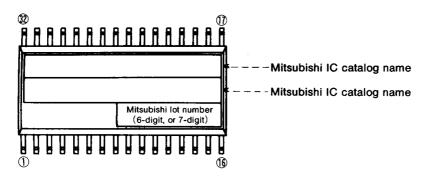


32P2W (32-PIN SOP) MARK SPECIFICATION FORM

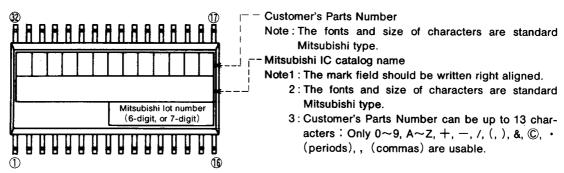
Mitsubishi IC catalog name	

Please choose one of the marking types below (A, B, C), and enter the Mitsubishi catalog name and the special mark (if needed).

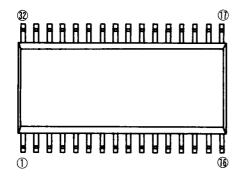
A. Standard Mitsubishi Mark



B. Customer's Parts Number + Mitsubishi catalog name



C. Special Mark Required



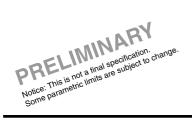
- Note1: If the Special Mark is to be printed, indicate the desired layout of the mark in the left figure. The layout will be duplicated as close as possible. Mitsubishi lot number (6-digit, or 7-digit) and Mask ROM number (3-digit) are always marked.
 - 2: If the customer's trade mark logo must be used in the Special Mark, check the box below. Please submit a clean original of the logo. For the new special character fonts a clean font original (ideally logo drawing) must be submitted.

Special	logo	required
---------	------	----------

3: The standard Mitsubishi font is used for all characters except for a logo.



Special logo required



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

42P4B (42-PIN SHRINK DIP) MARK SPECIFICATION FORM

	Mitsubishi IC catalog name	
Please choose mark (if neede	e one of the marking types below (A, B, C) , and enter the Mi ed).	tsubishi IC catalog name and the specia
A. Standard M	itsubishi Mark ↑↑↑↑↑↑↑↑↑↑↑↑↑↑↑↑↑↑↑↑	
	Mitsubishi lot number (6-digit or 7-digit)	
		subishi IC catalog name
0000		
B. Customer's	Parts Number + Mitsubishi Catalog Name	
@ <u>D</u> OO	<u>ՊՈՈՈՈՈՈՈՈՈՈՈՈՈՈՈ</u> ւթ	
	Not	stomer's parts number e: The fonts and size of characters are standard Mitsubishi type. subishi IC catalog name
	Mitsubishi lot number (6-digit or 7-digit)	
1)	<u> </u>	
	ark field should be written right aligned.	
	nts and size of characters are standard Mitsubishi type. ner's parts number can be up to 15 characters:	
	\sim 9, A \sim Z, $+$, $-$, $/$, (,), &, $\mathbb C$, . (period), and , (comma) are $\mathfrak c$	usable.
C. Special Ma	ark Poquired	
O. Special Ma Ph h		
Ĺ		
1) J J J	<u> </u>	
Note1 : If the s	special mark is to be printed, indicate the desired layout of the	e mark in the upper figure. The layout wil
are alv	olicated as close as possible. Mitsubishi lot number (6-digit or ways marked.	
2: If the	customer's trade mark logo must be used in the special mark priginal of the logo.	k, check the box below. Please submit a
Olouii (



For the new special character fonts a clean font original (ideally logo drawing) must be submitted.

The standard Mitsubishi font is used for all characters except for a logo.

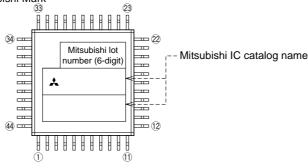


44P6N (44-PIN QFP) MARK SPECIFICATION FORM

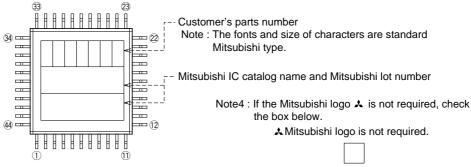
Mitsubishi IC catalog name

Please choose one of the marking types below (A, B, C), and enter the Mitsubishi IC catalog name and the special mark (if needed).

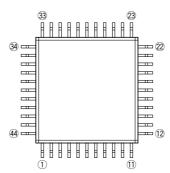
A. Standard Mitsubishi Mark



B. Customer's Parts Number + Mitsubishi Catalog Name



- Note1: The mark field should be written right aligned.
 - 2: The fonts and size of characters are standard Mitsubishi type.
 - 3: Customer's parts number can be up to 7 characters : Only $0 \sim 9$, $A \sim Z,+,-, \nearrow$, (,), &, ©, (period), and , (comma) are usable.
- C. Special Mark Required



- Note1: If the special mark is to be printed, indicate the desired layout of the mark in the left figure. The layout will be duplicated as close as possible.

 Mitsubishi lot number (6-digit) and mask ROM number (3-digit) are always marked.
 - 2: If the customer's trade mark logo must be used in the special mark, check the box below. Please submit a clean original of the logo. For the new special character fonts a clean font original (ideally logo drawing) must be submitted.

Special logo required

The standard Mitsubishi font is used for all characters except for a logo.



MITSUBISHI MICROCOMPUTERS 7480/7481 GROUP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER

Renesas Technology Corp.

Nippon Bldg.,6-2,Otemachi 2-chome,Chiyoda-ku,Tokyo,100-0004 Japan

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REVISION DESCRIPTION LIST

7480/7481 GROUP DATA SHEET

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1.0	First Edition	date 971130
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